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RTL8380M-VB-CG

MULTI-LAYER MANAGED 10*10/100/1000M-PORT SWITCH CONTROLLER

RTL8382M-VB-CG

MULTI-LAYER MANAGED 28*10/100/1000M-PORT SWITCH CONTROLLER

DATASHEET

(CONFIDENTIAL: Development Partners Only)

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Realtek Semiconductor Corp.

No. 2, Innovation Road II, Hsinchu Science Park, Hsinchu 300, Taiwan

Tel.: +886-3-578-0211 Fax: +886-3-577-6047

www.realtek.com

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USING THIS DOCUMENT

This document provides detailed user guidelines to achieve the best performance when implementing the Realtek Ethernet Switch Controllers.

Though every effort has been made to ensure that this document is current and accurate, more information may have become available subsequent to the production of this guide.

REVISION HISTORY

Revision	Release Date	Summary
1.0	2014/01/20	First release.
1.1	2016/1/8	Remove the support for 10M-EEE and I2C master for EEPROM.
1.2	2016/6/30	Separate unmanaged series RTL8382L.

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1. General Description

The RTL8380M-VB-CG and RTL8382M-VB-CG are new generation Gigabit switches supporting Energy Efficient Ethernet (EEE). The RTL8380M-VB is an 10-port 10/100/1000M switch controller, and the RTL8382M-VB is a 28-port 10/100/1000M switch controller. Both of them have an 8-port 10/100/1000M Ethernet PHY embedded.

The RTL8380M-VB/RTL8382M-VB are provided via a 55nm CMOS process in an LQFP-216 E-PAD package. The Memory interface of the RTL8380M-VB/RTL8382M-VB supports DDR1/DDR2/DDR3 and SPI Flash. The following table lists the main differences between the RTL8380M-VB/RTL8382M-VB:

Features	RTL8380M-VB	RTL8382M-VB
Port Capacity	8G*UTP + 2*1000Base-X	24G*UTP + 4GCombo
Management Mode	Managed Mode Only	Managed Mode Only
DDR1/2/3	Yes	Yes
SPI Flash	Yes	Yes
EEPROM Config.	Yes	Yes
Internal CPU	Yes	Yes

The RTL8380M-VB supports two-pairs of SGMII/1000Base-X.

The RTL8382M-VB support four pairs of serially connected QSGMII interface ports to connect to two Octal Gigabit PHYs (RTL8218B). The RTL8382M-VB also supports one serially connected QSGMII interface port to connect to 1 Quad Gigabit PHY (RTL8214FC).

The RTL8380M-VB/RTL8382M-VB have an embedded 500MHz MIPS-4KEc CPU that supports a 32MByte (max.) SPI flash and DDR1/DDR2/DDR3 memory interface. Two 16C550 compatible UARTs are integrated for low speed serial data, and one E-JTAG is supported for on-chip debugging.

There are 8K entries in the 4-way hash L2 table for MAC address learning and searching. The RTL8380M-VB/RTL8382M-VB supports two hash algorithms. An independent 512-entry Multicast table supports Layer 2 and IP multicast functions.

The RTL8380M-VB/RTL8382M-VB has a 4K-entry VLAN table for 802.1Q port-based, protocol-and-port-based, 802.1Q-based, IP-subnet-based, and ACL Rules-based VLAN operation to separate logical connectivity from physical connectivity. Support is provided for IVL (Independent VLAN Learning), SVL (Shared VLAN Learning), and IVL/SVL (both Independent and Shared VLAN Learning) for flexible network topology architecture. The RTL8380M-VB/RTL8382M-VB supports a 1.5K-entry Access Control List (ACL) that parses various protocol packet types and performs configurable actions, e.g., Permit/Drop, redirect, and traffic policing.

The RTL8380M-VB/RTL8382M-VB supports per-port ingress/egress bandwidth control and per-queue egress bandwidth control. It has 8 physical queues in each port. The RTL8380M-VB/RTL8382M-VB provides three types of packet scheduling; SP (Strict Priority), WFQ (Weighted Fair Queuing), and WRR (Weighted Round Robin). Each queue provides a leaky-bucket to shape the incoming traffic into the average rate behavior.

Port-based 802.1X and MAC-based 802.1X authentication prevent unauthorized users from accessing internal servers. The RTL8380M-VB/RTL8382M-VB supports port isolation to enhance port security. The RTL8380M-VB/RTL8382M-VB also supports a 4-set port mirror configuration to mirror ingress and egress traffic. For network management purposes, complete MIB counter support reflects the switch status in real time. Support is provided for link aggregation to increase link redundancy, and increase linear bandwidth.

The RTL8380M-VB/RTL8382M-VB adopts advanced technologies such as Realtek Cable Test (RTCT), Automatic loop detection and prevention (RLPP/RLDP), Attack Prevention, and MAC Address Learning Constraints.

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2. Features

■ Hardware Interface

- ◆ RTL8380M-VB
 - 10-port Gigabit wire speed forwarding capability
 - Supports 8-port 10/100/1000M Ethernet PHY
 - Supports two pairs of SGMII/1000Base-X
- ◆ RTL8382M-VB
 - RTL8382M-VB provides 28-port Gigabit wire speed forwarding capability
 - Supports 8-port 10/100/1000M Ethernet PHY
 - Support 4-pairs of QSGMII to connect to external 8-port 10/100/1000M Ethernet PHYs
 - RTL8382M-VB supports an extra 1 pair of QSGMII or 2 pairs of SGMII/1000Base-X
- ◆ DRAM and Flash Interface
 - Support one 8-bit 128MByte DDR1/DDR2 or one 8-bit 256MByte DDR3 for internal CPU
 - Support one 32MByte SPI flash interface
- ◆ Embedded MIPS-4KEc with MMU
 - MIPS32 instruction set and 5-stage pipeline
 - 500MHz CPU clock rate
 - 16KByte I-Cache and 16KByte D-Cache
 - Built-in 128KByte SRAM
 - 32 Translation Look-aside Buffer (TLB) entries
 - Two UART interfaces to control the internal CPU via a Command Line Interface (CLI)
- ◆ Supports EJTAG interface

- ◆ I2C and slave SPI interface for external master interface to access internal registers

■ L2 VLAN Function

- ◆ Supports IVL, SVL, and IVL/SVL
- ◆ Supports IEEE 802.1Q VLAN
 - 4K-entry VLAN Table
 - Port-based VLAN
 - Port-and-protocol-based VLAN
 - ACL-based VLAN
 - Supports up to 64 spanning tree instances for MSTP (IEEE 802.1s), RSTP, and STP
- ◆ Supports flexible Q-in-Q and VLAN Tag function

■ L2 MAC Function

- ◆ 4.1 Mbit SRAM Packet Buffer
- ◆ Packet length of 10000Bytes
- ◆ 8K-entry L2 MAC table with 4-way hashing algorithm
- ◆ Independent 512-entry L2/IP Multicast table for multicast function
- ◆ 2-hash algorithm selection for L2 table searching/learning
- ◆ Aging timer range from 0.2s to 1600000s
- ◆ Supports IGMPv1/2/3 and MLDv1/2 snooping
- ◆ Supports Reserved Multicast Addresses processing
- ◆ Limited learned L2 MAC entry on each port and each VLAN

■ **L2 Miscellaneous Functions**

- ◆ Supports broadcast, multicast, unknown-multicast, and unknown-unicast packet suppression control
- ◆ Software supports IEEE 802.1x,
- ◆ Supports Port Mirroring
 - Supports 4-sets of port mirrors
 - Flow-based mirror function
 - RSPAN function for remote mirroring
- ◆ Supports Link Aggregation (IEEE 802.3ad) for 8 groups of link aggregators with up to 8 ports per-group
- ◆ Port isolation function to enhance port security
- ◆ Attack Prevention
 - Land attack
 - Blat attack
 - TCP control flag attack
 - Ping attack
 - Packet length attack
- ◆ Supports Automatic loop detection and isolation (RLPP/RLDP)

■ **Access Control List (ACL) Function**

- ◆ 1.5K-entry ACL table
- ◆ L2/L3/L4 format (e.g., DMAC, SMAC, and Ether-Type)
- ◆ IPv6 Parsing
- ◆ Per-flow traffic policing
- ◆ 16-entry VID range checking
- ◆ 8-entry IPv4 or 2-entry IPv6 range checking
- ◆ 256 leaky-buckets for flow traffic policing; in 16Kbps steps up to 1Gbps maximum
- ◆ 256 log counters to enhance MIB count functionality

- ◆ Supports multiple actions

- ◆ Supports L3 Unicast Routing, 512 next hop MAC Support

■ **QoS Functions**

- ◆ 8 physical queues per port
- ◆ Strict Priority (SP) and Weighted Fair Queue (WFQ), Weighted Round Robin (WRR) packet scheduling
- ◆ QoS remarking for 802.1p and DSCP (includes IPv4/IPv6)
- ◆ Supports average packet rate control leaky-bucket per queue, in 16Kbps steps up to 1Gbps maximum
- ◆ Ingress port bandwidth control, in 16Kbps steps up to 1Gbps maximum
- ◆ Egress port bandwidth control, in 16Kbps steps up to 1Gbps maximum

■ **EAV, 1588v2**

■ **Cable Diagnostics (RTCT)**

■ **IEEE 802.3az Energy Efficient Ethernet (EEE)**

■ **MIB Functions**

- ◆ Ethernet-like MIB (RFC 3635)
- ◆ Interface Group MIB (RFC 2863)
- ◆ RMON (RFC 2819)
- ◆ Bridge MIB (RFC 1493)
- ◆ Bridge MIB Extension (RFC 2674)

■ **Others**

- ◆ 55nm CMOS process
- ◆ 3.3V/1.1V dual power input
- ◆ LQFP216 E-PAD package

3. System Applications

3.1. *RTL8380M-VB: Managed 8*1000M UTP+2*1000Base-X Switch*

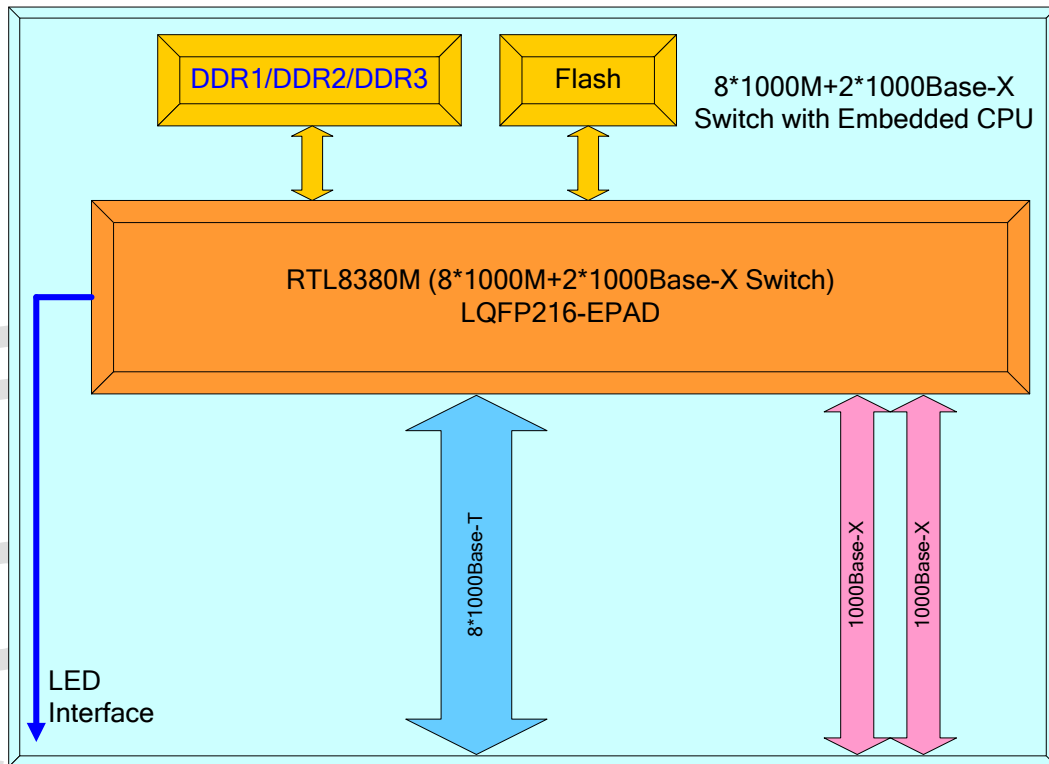


Figure 1. Managed 8*1000M UTP+2*1000Base-X Switch

3.2. *RTL8382M-VB: Managed 28*1000M Switch via RTL8218B PHY*

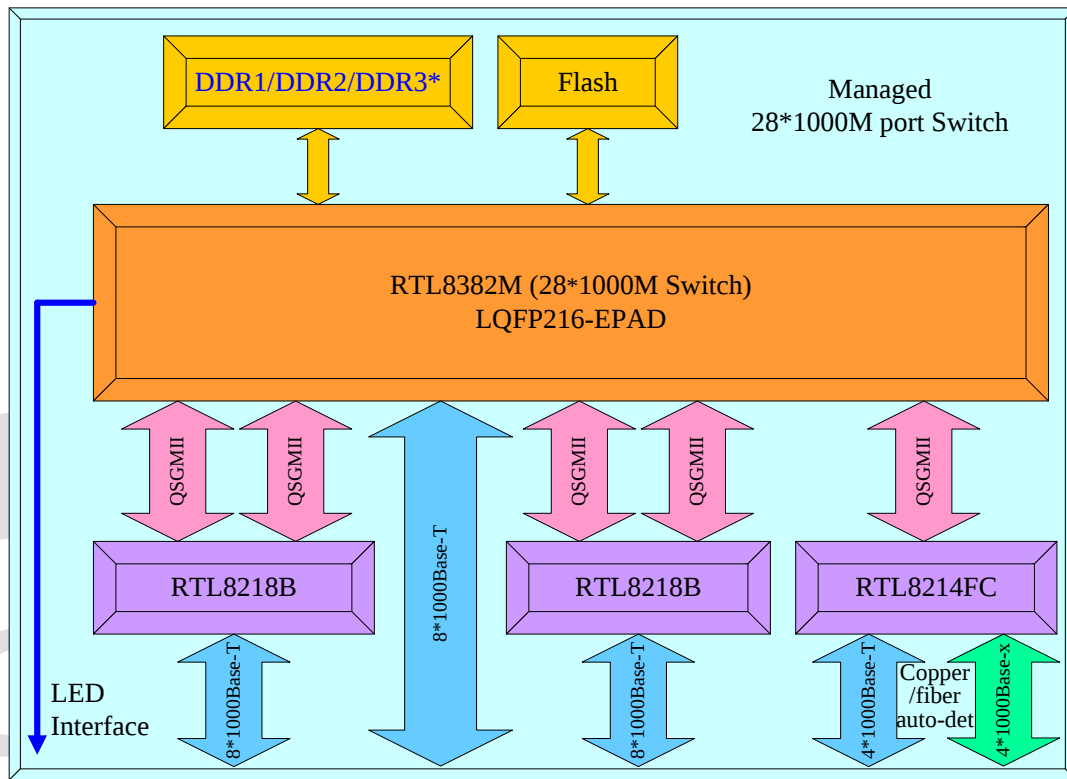


Figure 2. Managed 28*1000M Switch via RTL8218B PHY

3.3. RTL8382M-VB: Managed 20*1000M UTP+4*1000M Combo Switch

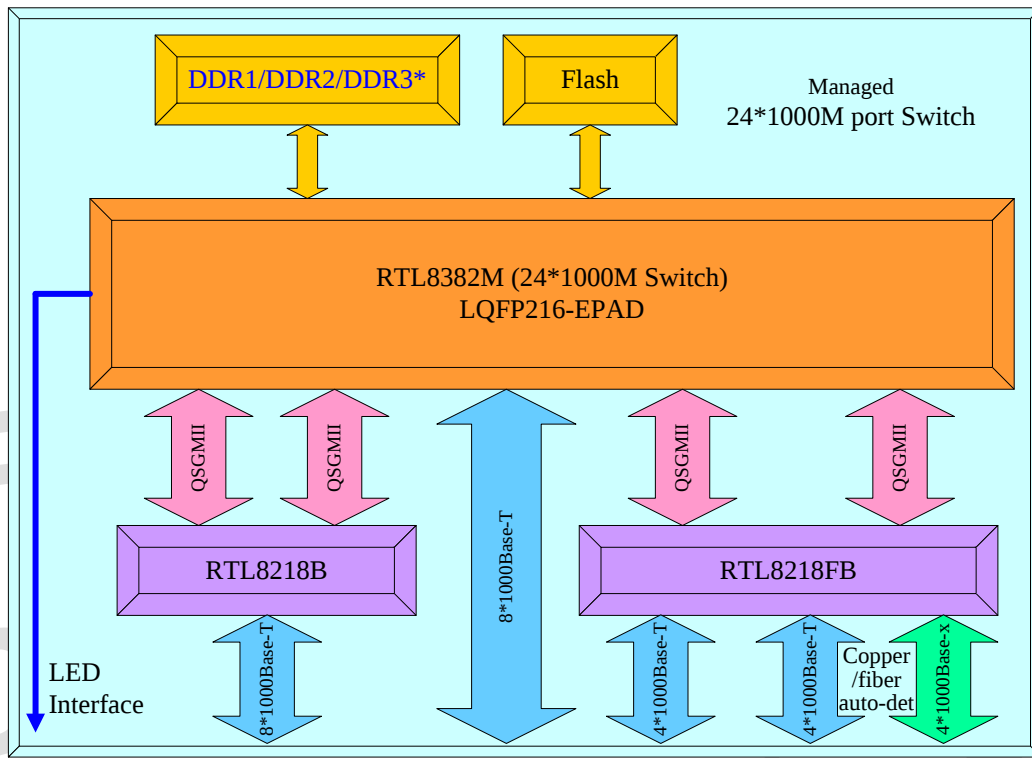


Figure 3. Managed 20*1000M UTP+4*1000M Combo Switch

3.4. RTL8382M-VB: Managed 24*1000M UTP+2*1000Base-X Switch

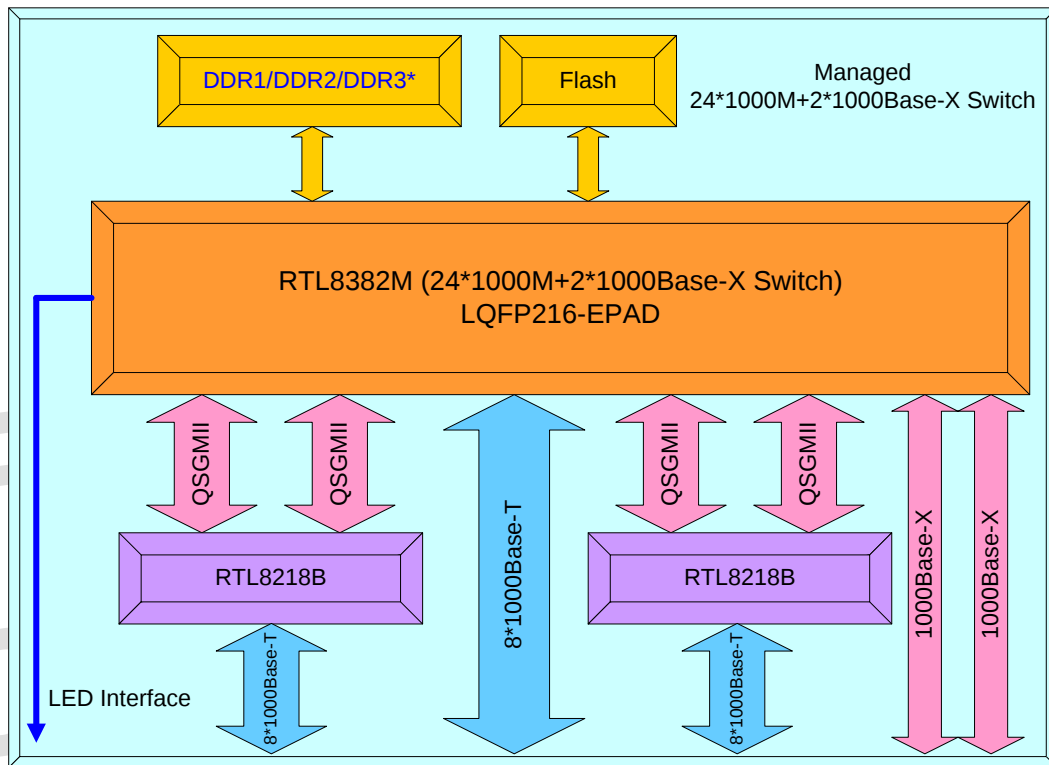


Figure 4. Managed 24*1000M UTP+2*1000Base-X Switch

4. Block Diagrams

4.1. RTL8380M-VB Block Diagram

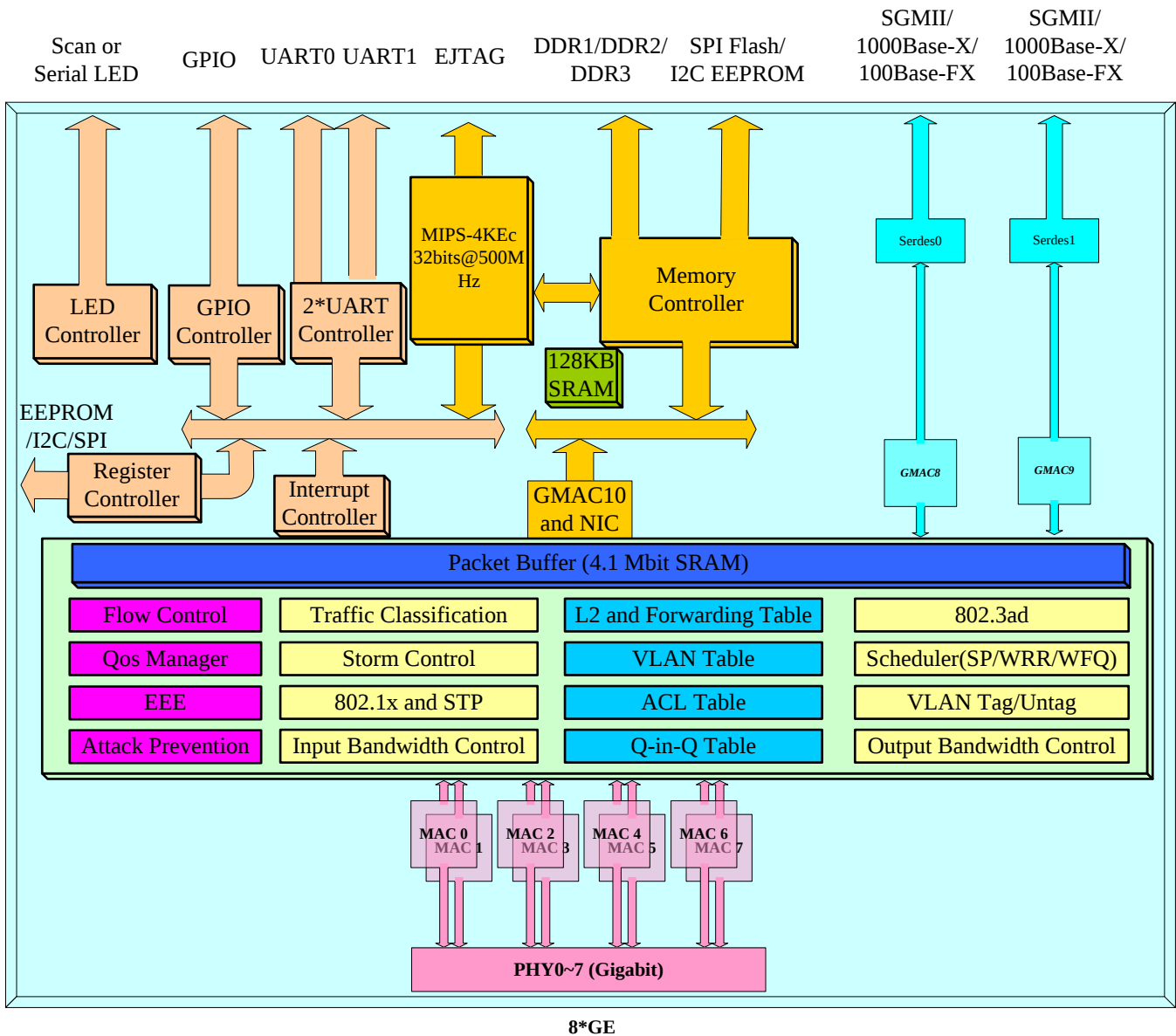


Figure 5. RTL8380M-VB Block Diagram

4.2. RTL8382M-VB Block Diagram

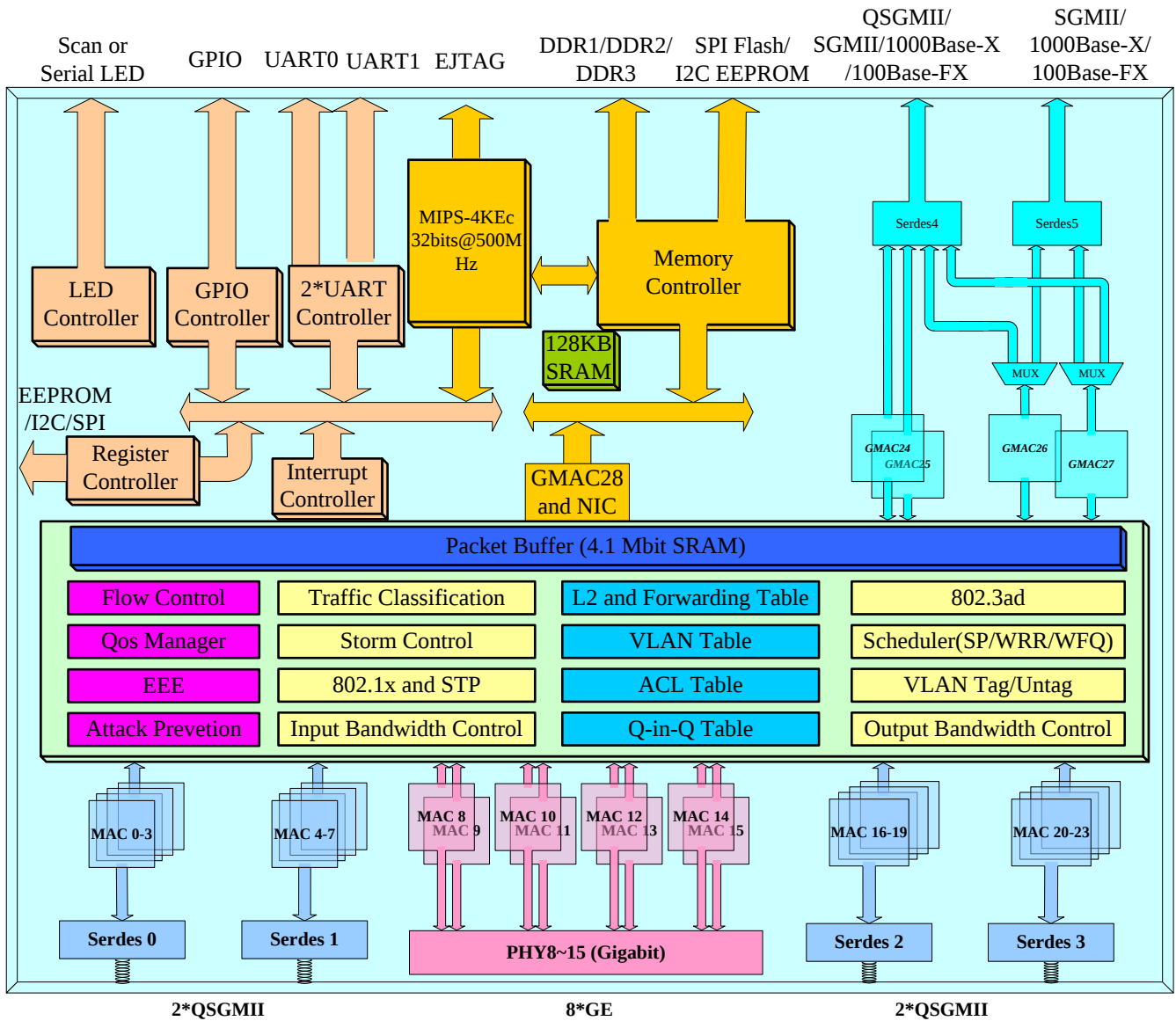


Figure 6. RTL8382M-VB Block Diagram

5. Pin Assignments and Description (RTL8380M-VB)

5.1. Pin Assignments Figure (RTL8380M-VB)

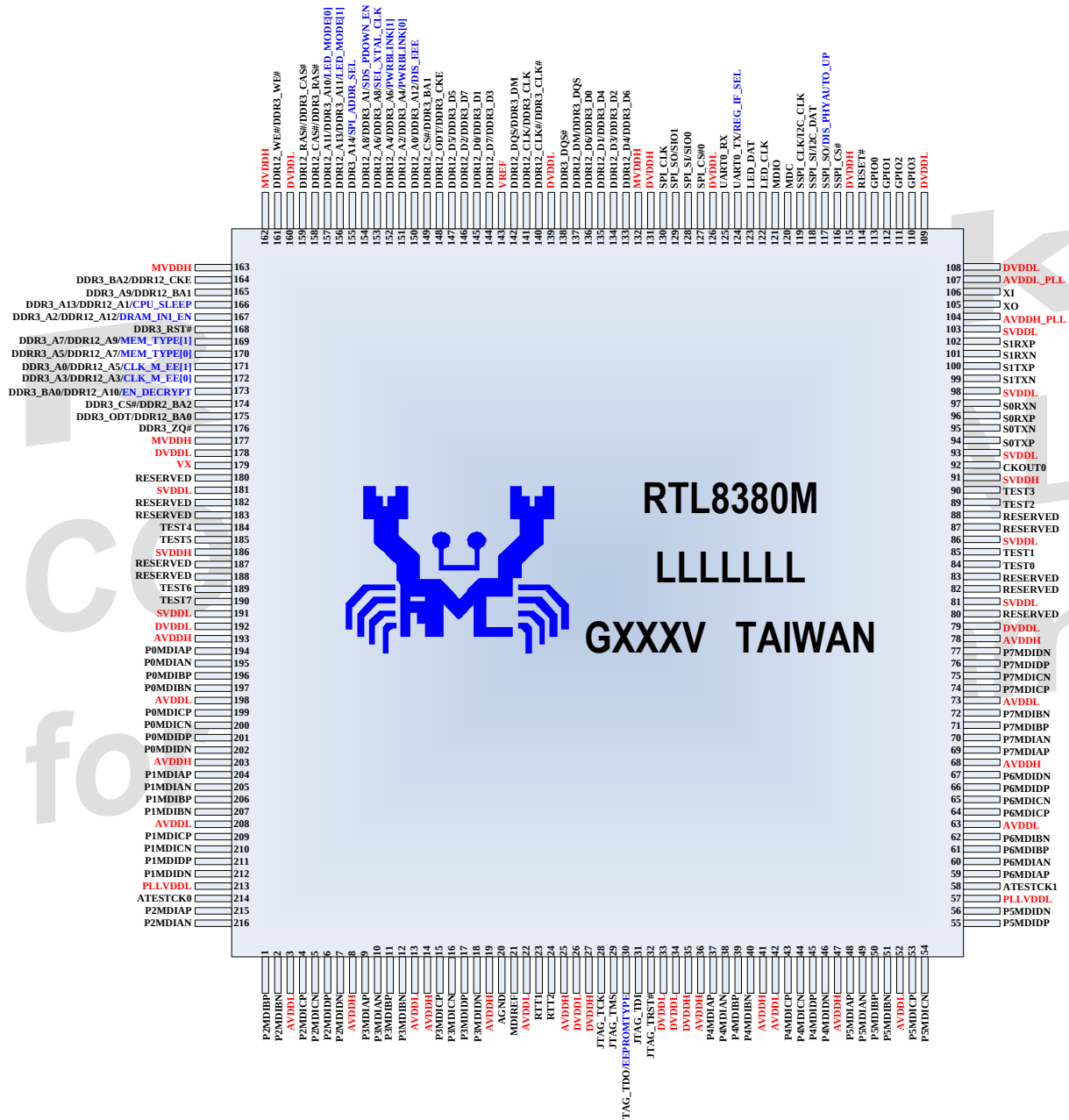


Figure 7. Pin Assignments (RTL8380M-VB)

5.2. Package Identification

Green package is indicated by a 'G' in 'GXXXX' (Figure 7). The version number is shown in the location marked 'V'.

5.3. Pin Assignments Table Codes (RTL8380M-VB)

Upon Reset: Defined as a short time after the end of a hardware reset.

After Reset: Defined as the time after the specified 'Upon Reset' time.

I: Input Pin	AI: Analog Input Pin
O: Output Pin	AO: Analog Output Pin
I/O: Bi-Directional Input/Output Pin	AI/O: Analog Bi-Directional Input/Output Pin
P: Digital Power Pin	AP: Analog Power Pin
G: Digital Ground Pin	AG: Analog Ground Pin
I _{PU} : Input Pin With Pull-Up Resistor; (Typical Value = 75KΩ)	O _{PU} : Output Pin With Pull-Up Resistor; (Typical Value = 75KΩ)
I _{PD} : Input Pin With Pull-Down Resistor; (Typical Value = 75KΩ)	O _{PD} : Output Pin With Pull-Down Resistor; (Typical Value = 75KΩ)

5.4. Pin Assignments Table (RTL8380M-VB)

Table 1. Pin Assignments Table (RTL8380M-VB)

Name	Pin No.	Type	Name	Pin No.	Type
P2MDIBP	1	AI/O	AVDDH	19	AP
P2MDIBN	2	AI/O	AGND	20	AG
AVDDL	3	AP	MDIREF	21	AO
P2MDICP	4	AI/O	AVDDL	22	AP
P2MDICN	5	AI/O	RTT1	23	AI/O
P2MDIDP	6	AI/O	RTT2	24	AI/O
P2MDIDN	7	AI/O	AVDDH	25	AP
AVDDH	8	AP	DVDDL	26	DP
P3MDIAP	9	AI/O	DVDDH	27	DP
P3MDIAN	10	AI/O	JTAG_TCK	28	I/O _{PU}
P3MDIBP	11	AI/O	JTAG_TMS	29	I/O _{PU}
P3MDIBN	12	AI/O	JTAG_TDO/EEPROMTYPE	30	I/O _{PD}
AVDDL	13	AP	JTAG_TDI	31	I/O _{PD}
AVDDH	14	AP	JTAG_TRST#	32	I/O _{PU}
P3MDICP	15	AI/O	DVDDL	33	DP
P3MDICN	16	AI/O	DVDDH	34	DP
P3MDIDP	17	AI/O	DVDDH	35	DP
P3MDIDN	18	AI/O	AVDDH	36	AP

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Datasheet

Name	Pin No.	Type
P4MDIAP	37	AI/O
P4MDIAN	38	AI/O
P4MDIBP	39	AI/O
P4MDIBN	40	AI/O
AVDDH	41	AP
AVDDL	42	AP
P4MDICP	43	AI/O
P4MDICN	44	AI/O
P4MDIDP	45	AI/O
P4MDIDN	46	AI/O
AVDDH	47	AP
P5MDIAP	48	AI/O
P5MDIAN	49	AI/O
P5MDIBP	50	AI/O
P5MDIBN	51	AI/O
AVDDL	52	AP
P5MDICP	53	AI/O
P5MDICN	54	AI/O
P5MDIDP	55	AI/O
P5MDIDN	56	AI/O
PLLVDL	57	AP
ATESTCK1	58	AO
P6MDIAP	59	AI/O
P6MDIAN	60	AI/O
P6MDIBP	61	AI/O
P6MDIBN	62	AI/O
AVDDL	63	AP
P6MDICP	64	AI/O
P6MDICN	65	AI/O
P6MDIDP	66	AI/O
P6MDIDN	67	AI/O
AVDDH	68	AP
P7MDIAP	69	AI/O
P7MDIAN	70	AI/O
P7MDIBP	71	AI/O
P7MDIBN	72	AI/O
AVDDL	73	AP
P7MDICP	74	AI/O
P7MDICN	75	AI/O
P7MDIDP	76	AI/O
P7MDIDN	77	AI/O

Name	Pin No.	Type
AVDDH	78	AP
DVDDL	79	DP
RESERVED	80	-
SVDDL	81	AP
RESERVED	82	-
RESERVED	83	-
TEST0	84	-
TEST1	85	-
SVDDL	86	AP
RESERVED	87	-
RESERVED	88	-
TEST2	89	-
TEST3	90	-
SVDDH	91	AP
CKOUT0	92	AO
SVDDL	93	AP
S0TXP	94	AO
S0TXN	95	AO
S0RXP	96	AI
S0RXN	97	AI
SVDDL	98	AP
S1TXN	99	AO
S1TXP	100	AO
S1RXN	101	AI
S1RXP	102	AI
SVDDL	103	AP
AVDDH_PLL	104	AP
XO	105	AO
XI	106	AI
AVDDL_PLL	107	AP
DVDDL	108	P
DVDDL	109	P
GPIO3	110	I/O _{PD}
GPIO2	111	I/O _{PD}
GPIO1	112	I/O _{PD}
GPIO0	113	I/O _{PD}
RESET#	114	AI
DVDDH	115	P
SSPI_CS#	116	I _{PU}
SSPI_SO/ DIS_PHYAUTO_UP	117	I/O _{PD}
SSPI_SI/I2C_DAT	118	I/O _{PU}

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Datasheet

Name	Pin No.	Type
SSPI_CLK/I2C_CLK	119	I/O _{PU}
MDC	120	O _{PU}
MDIO	121	I/O _{PU}
LED_CLK	122	O _{PU}
LED_DAT	123	I/O _{PU}
UART0_TX/REG_IF_SEL	124	I/O _{PD}
UART0_RX	125	I _{PD}
DVDDL	126	P
SPI_CS#0	127	I _{PU}
SPI_SI/SIO0	128	I/O _{PD}
SPI_SO/SIO1	129	I/O _{PD}
SPI_CLK	130	O _{PD}
DVDDH	131	P
MVDDH	132	P
DDR12_D4/DDR3_D6	133	I/O
DDR12_D3/DDR3_D2	134	I/O
DDR12_D1/DDR3_D4	135	I/O
DDR12_D6/DDR3_D0	136	I/O
DDR12_DM/DDR3_DQS	137	I/O
DDR3_DQS#	138	I/O
DVDDL	139	P
DDR12_CLK#/DDR3_CLK#	140	O
DDR12_CLK/DDR3_CLK	141	O
DDR12_DQS/DDR3_DM	142	I/O
VREF	143	P
DDR12_D7/DDR3_D3	144	I/O
DDR12_D0/DDR3_D1	145	I/O
DDR12_D2/DDR3_D7	146	I/O
DDR12_D5/DDR3_D5	147	I/O
DDR2_ODT/DDR3_CKE	148	O
DDR12_CS#/DDR3_BA1	149	O
DDR12_A0/DDR3_A12/ DIS_EEE	150	I/O
DDR12_A2/DDR3_A4/ PWRBLINK[0]	151	I/O
DDR12_A4/DDR3_A6/ PWRBLINK[1]	152	I/O
DDR12_A6/DDR3_A8/ SEL_XTAL_CLK	153	I/O
DDR12_A8/DDR3_A1/ SDS_PDOWN_EN	154	I/O
DDR3_A14/SPI_ADDR_SEL	155	I/O

Name	Pin No.	Type
DDR12_A13/DDR3_A11/ LED/MODE[1]	156	I/O
DDR12_A11/DDR3_A10/ LED/MODE[0]	157	I/O
DDR12_CAS#/DDR3_RAS#	158	O
DDR12_RAS#/DDR3_CAS#	159	O
DVDDL	160	P
DDR12_WE#/DDR3_WE#	161	O
MVDDH	162	P
MVDDH	163	P
DDR12_CKE/DDR3_BA2	164	O
DDR12_BA1/DDR3_A9	165	O
DDR12_A1/DDR3_A13/ CPU_SLEEP	166	I/O
DDR12_A12/DDR3_A2/ DRAM_INI_EN	167	I/O
DDR3_RST#	168	O
DDR12_A9/DDR3_A7/ MEM_TYPE[1]	169	I/O
DDR12_A7/DDR3_A5/ MEM_TYPE[0]	170	I/O
DDR12_A5/DDR3_A0/ CLK_M_EE[1]	171	I/O
DDR12_A3/DDR3_A3/ CLK_M_EE[0]	172	I/O
DDR12_A10/DDR3_BA0/ EN_DECRYPT	173	I/O
DDR2_BA2/DDR3_CS#	174	O
DDR12_BA0/DDR3_ODT	175	O
DDR3_ZQ#	176	O
MVDDH	177	P
DVDDL	178	P
VX	179	A
RESERVED	180	AO
SVDDL	181	AP
RESERVED	182	AO
RESERVED	183	AO
TEST4	184	-
TEST5	185	-
SVDDH	186	AP
RESERVED	187	AO
RESERVED	188	AO
TEST6	189	-
TEST7	190	-

Name	Pin No.	Type
SVDDL	191	AP
DVDDL	192	P
AVDDH	193	AP
P0MDIAP	194	AI/O
P0MDIAN	195	AI/O
P0MDIBP	196	AI/O
P0MDIBN	197	AI/O
AVDDL	198	AP
P0MDICP	199	AI/O
P0MDICN	200	AI/O
P0MDIDP	201	AI/O
P0MDIDN	202	AI/O
AVDDH	203	AP
P1MDIAP	204	AI/O

Name	Pin No.	Type
P1MDIAN	205	AI/O
P1MDIBP	206	AI/O
P1MDIBN	207	AI/O
AVDDL	208	AP
P1MDICP	209	AI/O
P1MDICN	210	AI/O
P1MDIDP	211	AI/O
P1MDIDN	212	AI/O
PLLVDL	213	AP
ATESTCK0	214	AO
P2MDIAP	215	AI/O
P2MDIAN	216	AI/O
DGND	EPAD	G

5.5. Pin Descriptions (RTL8380M-VB)

5.5.1. 1000M Ethernet PHY MDI Interface Pins

Table 2. 1000M Ethernet PHY MDI Interface Pins

Pin Name	Pin No.	Type	Description
P0MDIAP	194	AI/O	Port 0 Media Dependent Interface A~D. For 1000Base-T operation, differential data from the media is transmitted and received on all four pairs. For 100Base-Tx and 10Base-T operation, only MDIAP/N and MDIBP/N are used. Auto MDIX can reverse the pairs MDIAP/N and MDIBP/N. Each of the differential pairs has an internal 100 ohm termination resistor.
P0MDIAN	195	AI/O	
P0MDIBP	196	AI/O	
P0MDIBN	197	AI/O	
P0MDICP	199	AI/O	
P0MDICN	200	AI/O	
P0MDIDP	201	AI/O	
P0MDIDN	202	AI/O	
P1MDIAP	204	AI/O	Port 1 Media Dependent Interface A~D. For 1000Base-T operation, differential data from the media is transmitted and received on all four pairs. For 100Base-Tx and 10Base-T operation, only MDIAP/N and MDIBP/N are used. Auto MDIX can reverse the pairs MDIAP/N and MDIBP/N. Each of the differential pairs has an internal 100 ohm termination resistor.
P1MDIAN	205	AI/O	
P1MDIBP	206	AI/O	
P1MDIBN	207	AI/O	
P1MDICP	209	AI/O	
P1MDICN	210	AI/O	
P1MDIDP	211	AI/O	
P1MDIDN	212	AI/O	
P2MDIAP	215	AI/O	Port 2 Media Dependent Interface A~D. For 1000Base-T operation, differential data from the media is transmitted and received on all four pairs. For 100Base-Tx and 10Base-T operation, only MDIAP/N and MDIBP/N are used. Auto MDIX can reverse the pairs MDIAP/N and MDIBP/N. Each of the differential pairs has an internal 100 ohm termination resistor.
P2MDIAN	216	AI/O	
P2MDIBP	1	AI/O	
P2MDIBN	2	AI/O	
P2MDICP	4	AI/O	
P2MDICN	5	AI/O	
P2MDIDP	6	AI/O	
P2MDIDN	7	AI/O	
P3MDIAP	9	AI/O	Port 3 Media Dependent Interface A~D. For 1000Base-T operation, differential data from the media is transmitted and received on all four pairs. For 100Base-Tx and 10Base-T operation, only MDIAP/N and MDIBP/N are used. Auto MDIX can reverse the pairs MDIAP/N and MDIBP/N. Each of the differential pairs has an internal 100 ohm termination resistor.
P3MDIAN	10	AI/O	
P3MDIBP	11	AI/O	
P3MDIBN	12	AI/O	
P3MDICP	15	AI/O	
P3MDICN	16	AI/O	
P3MDIDP	17	AI/O	
P3MDIDN	18	AI/O	

Pin Name	Pin No.	Type	Description
P4MDIAP	37	AI/O	Port 4 Media Dependent Interface A~D. For 1000Base-T operation, differential data from the media is transmitted and received on all four pairs. For 100Base-Tx and 10Base-T operation, only MDIAP/N and MDIBP/N are used. Auto MDIX can reverse the pairs MDIAP/N and MDIBP/N. Each of the differential pairs has an internal 100 ohm termination resistor.
P4MDIAN	38	AI/O	
P4MDIBP	39	AI/O	
P4MDIBN	40	AI/O	
P4MDICP	43	AI/O	
P4MDICN	44	AI/O	
P4MDIDP	45	AI/O	
P4MDIDN	46	AI/O	
P5MDIAP	48	AI/O	Port 5 Media Dependent Interface A~D. For 1000Base-T operation, differential data from the media is transmitted and received on all four pairs. For 100Base-Tx and 10Base-T operation, only MDIAP/N and MDIBP/N are used. Auto MDIX can reverse the pairs MDIAP/N and MDIBP/N. Each of the differential pairs has an internal 100 ohm termination resistor.
P5MDIAN	49	AI/O	
P5MDIBP	50	AI/O	
P5MDIBN	51	AI/O	
P5MDICP	53	AI/O	
P5MDICN	54	AI/O	
P5MDIDP	55	AI/O	
P5MDIDN	56	AI/O	
P6MDIAP	59	AI/O	Port 6 Media Dependent Interface A~D. For 1000Base-T operation, differential data from the media is transmitted and received on all four pairs. For 100Base-Tx and 10Base-T operation, only MDIAP/N and MDIBP/N are used. Auto MDIX can reverse the pairs MDIAP/N and MDIBP/N. Each of the differential pairs has an internal 100 ohm termination resistor.
P6MDIAN	60	AI/O	
P6MDIBP	61	AI/O	
P6MDIBN	62	AI/O	
P6MDICP	64	AI/O	
P6MDICN	65	AI/O	
P6MDIDP	66	AI/O	
P6MDIDN	67	AI/O	
P7MDIAP	69	AI/O	Port 7 Media Dependent Interface A~D. For 1000Base-T operation, differential data from the media is transmitted and received on all four pairs. For 100Base-Tx and 10Base-T operation, only MDIAP/N and MDIBP/N are used. Auto MDIX can reverse the pairs MDIAP/N and MDIBP/N. Each of the differential pairs has an internal 100 ohm termination resistor.
P7MDIAN	70	AI/O	
P7MDIBP	71	AI/O	
P7MDIBN	72	AI/O	
P7MDICP	74	AI/O	
P7MDICN	75	AI/O	
P7MDIDP	76	AI/O	
P7MDIDN	77	AI/O	

5.5.2. SGMII Interface Pins

Table 3. SGMII Interface Pins

Pin Name	Pin No.	Type	Description
S0RXP	96	AI	SGMII Interface Receive Data Differential Input Pair.
S0RXN	97	AI	
S0TXP	94	AO	SGMII Interface Transmit Data Differential Output Pair.
S0TXN	95	AO	
S1RXP	102	AI	SGMII Interface Receive Data Differential Input Pair.
S1RXN	101	AI	
S1TXP	100	AO	SGMII Interface Transmit Data Differential Output Pair.
S1TXN	99	AO	

5.5.3. 1000Base-X/100Base-FX Interface Pins

Table 4. 1000Base-X/100Base-FX Interface Pins

Pin Name	Pin No.	Type	Description
S0RXP	96	AI	1000Base-X/100Base-FX Interface Receive Data Differential Input Pair.
S0RXN	97	AI	
S0TXP	94	AO	1000Base-X/100Base-FX Interface Transmit Data Differential Output Pair.
S0TXN	95	AO	
S1RXP	102	AI	1000Base-X/100Base-FX Interface Receive Data Differential Input Pair.
S1RXN	101	AI	
S1TXP	100	AO	1000Base-X/100Base-FX Interface Transmit Data Differential Output Pair.
S1TXN	99	AO	

5.5.4. DDR1/2 SDRAM Interface Pins

Table 5. DDR1/2 SDRAM Interface Pins

Pin Name	Pin No.	Type	Drive (mA)	Description
DDR12_D[7:0]	144, 136, 147, 133, 134, 146, 135, 145	I/O	8	DDR SDRAM Data Bus.
DDR12_A[13:0]	156, 167, 157, 173, 169, 154, 170, 153, 171, 152, 172, 151, 166, 150	I/O	8	DDR SDRAM Address Select.
DDR2_BA[2]	174	O	8	DDR SDRAM Bank Address Select.
DDR12_BA[1:0]	165, 175	O	8	DDR SDRAM Bank Address Select.
DDR12_WE#	161	O	8	DDR SDRAM Write Enable.
DDR12_CKE	164	O	8	DDR SDRAM Clock Enable.
DDR12_RAS#	159	O	8	DDR SDRAM Row Address Strobe.
DDR12_CAS#	158	O	8	DDR SDRAM Column Address Strobe.
DDR12_CS#0	149	O	8	DDR SDRAM Chip Select 0.
DDR2_ODT	148	O	8	DDR SDRAM On-Die Termination.
DDR12_DQS	142	I/O	8	DDR SDRAM Data Strobe.
DDR12_CLK	141	O	8	DDR SDRAM Clock. CLK and CLK# are differential clock outputs.
DDR12_CLK#	140	O	8	DDR SDRAM Clock. CLK and CLK# are differential clock outputs.

5.5.5. DDR3 SDRAM Interface Pins

Table 6. DDR3 SDRAM Interface Pins

Pin Name	Pin No.	Type	Drive (mA)	Description
DDR3_D[7:0]	146, 133, 147, 135, 144, 134, 145, 136	I/O	8	DDR SDRAM Data Bus.
DDR3_A[14]	155	O	8	DDR SDRAM Address Select.
DDR3_A[13:10]	166, 150, 156, 157	I/O	8	DDR SDRAM Address Select.
DDR3_A[9]	165	O	8	DDR SDRAM Address Select.
DDR3_A[8:0]	153, 169, 152, 170, 151, 172, 167, 154, 171	I/O	8	DDR SDRAM Address Select.
DDR3_DQS#	138	I/O	8	DDR SDRAM Data Strobe.
DDR3_DQS	137	I/O	8	DDR SDRAM Data Strobe.
DDR3_CLK#	140	O	8	DDR SDRAM Clock.
DDR3_CLK	141	O	8	DDR SDRAM Clock.
DDR3_DM	142	I/O	8	DDR SDRAM Data Mask.
DDR3_CKE	148	O	8	DDR SDRAM Clock Enable.
DDR3_BA[2:1]	164, 149	O	8	DDR SDRAM Bank Address Select.
DDR3_BA[0]	173	I/O	8	DDR SDRAM Bank Address Select.
DDR3_RAS#	158	O	8	DDR SDRAM Row Address Strobe.
DDR3_CAS#	159	O	8	DDR SDRAM Column Address Strobe.
DDR3_WE#	161	O	8	DDR SDRAM Write Enable.
DDR3_RST#	168	O	8	DDR SDRAM Reset.
DDR3_CS#	174	O	8	DDR SDRAM Chip Select.
DDR3_ODT	175	O	8	DDR SDRAM On-Die Termination.
DDR3_ZQ#	176	O	8	DDR SDRAM External Reference Ball for Output Drive Calibration. This ball is tied to an external 240 Ohm resistor, which is tied to GND.

5.5.6. Master Mode SPI Flash Interface Pins

Table 7. Master Mode SPI Flash Interface Pins

Pin Name	Pin No.	Type	Drive (mA)	Description
SPI_CLK	130	O _{PD}	12	Serial Clock Output Pin.
SPI_SO/SIO1	129	I/O _{PD}	12	In Serial Mode: This is a flash chip output pin In Dual Mode: This is a flash chip bi-directional pin <i>Note: This is MSB first.</i>
SPI_SI/SIO0	128	I/O _{PD}	12	In Serial Mode: This is a flash chip input pin In Dual Mode: This is a flash chip bi-directional pin <i>Note: This is LSB first.</i>
SPI_CS#0	127	O	12	Chip Select Output Pin. Slave Transmit Enable and active low.

5.5.7. UART Interface Pins

Table 8. UART Interface Pins

Pin Name	Pin No.	Type	Drive (mA)	Description
UART0_RX	125	I _{PD}	4	UART0 Interface Receive Data.
UART0_TX	124	I/O _{PD}	4	UART0 Interface Transmit Data.
UART1_RX	116	I _{PU}	4	UART1 Interface Receive Data.
UART1_TX	117	I/O _{PD}	4	UART1 Interface Transmit Data.

5.5.8. LED Interface Pins

Table 9. LED Interface Pins

Pin Name	Pin No.	Type	Drive (mA)	Description
LED_CLK	122	O _{PU}	12	(1) In Serial LED Mode Reference output clock for serial LED interface and Data is latched on the rising of LEDCK. (2) In SMI-like LED Mode Reference output clock for I2C-like interface.
LED_DAT	123	I/O _{PU}	12	(1) In Serial LED Mode Serial bit stream of link status information. (2) In I2C-like LED Mode The data written to the LED IC.

5.5.9. GPIO Interface Pins

Table 10. GPIO Interface Pins

Pin Name	Pin No.	Type	Drive (mA)	Description
GPIO0	113	I/O _{PD}	4	This pin default set as system LED. Can be configured as General Purpose Input/Output Pin.
GPIO[3:1]	110, 111, 112	I/O _{PD}	4	General Purpose Input/Output Pins.
GPO10	30	I/O _{PD}	4	General Purpose Output Pins.
GPIO11	31	I/O _{PD}	4	General Purpose Input/Output Pins.
GPIO[14:12]	32,28,29	I/O _{PU}	4	General Purpose Input/Output Pins.

5.5.10. EJTAG Interface Pins

Table 11. EJTAG Interface Pins

Pin Name	Pin No.	Type	Drive (mA)	Description
JTAG_TMS	29	I/O _{PU}	4	JTAG Test Mode Select.
JTAG_TCK	28	I/O _{PU}	4	JTAG Test Clock Input.
JTAG_TRST#	32	I/O _{PU}	4	JTAG Test Reset.
JTAG_TDI	31	I/O _{PD}	4	JTAG Test Data Input.
JTAG_TDO	30	I/O _{PD}	4	JTAG Test Data Output.

5.5.11. Configuration Strapping Pins

Table 12. Configuration Strapping Pins

Pin Name	Pin No.	Default	Description
EEPROMTYPE	30	0b0	Select EEPROM Address Byte Size. 0b0: 1-byte 0b1: 2-byte
DIS_PHYAUTO_UP	117	0b0	Disable ASIC Auto Power Up PHY. 0b0: Enable ASIC auto power up PHY 0b1: Disable ASIC auto power up PHY
REG_IF_SEL	124	0b0	Select Switch Core Register Access Interface. 0b0: I2C 0b1: SPI slave
DIS_EEE	150	0b0	Disable 1000M EEE and 100M EEE Function. 0b0: Enable 0b1: Disable
PWRBLINK[1:0]	152, 151	0b00	Select LED Power On Blinking Timer. 0b00: Disable 0b10: 1.6s 0b01: 800ms 0b11: 3.2s
SEL_XTAL_CLK	153	0b0	Select XTAL Input is 25M or 125M. 0b0: 25M 0b1: 125M <i>Note: This option is only for sync Ethernet.</i>
SDS_PDOWN_EN	154	0b0	Enable SerDes Power Down Mode. 0b0: SerDes 0/1 operate in normal mode 0b1: SerDes 0/1 operate in power down mode
SPI_ADDR_SEL	155	0b0	Select Address Mode for SPI Flash. 0b0: 3-byte address 0b1: 4-byte address
LED_MODE[1:0]	156, 157	0b0	Select LED Mode. 0b00: Serial LED mode 0b10: Scan Bicolor mode 0b01: Scan Single mode 0b11: Disable LED
CPU_SLEEP	166	0b0	Enable CPU Function. 0b0: CPU is always under reset state 0b1: CPU is enabled
DRAM_INI_EN	167	0b0	Enable DRAM Initialization Procedure. 0b0: Enable DRAM Initialization procedure 0b1: Bypass DRAM Initialization procedure
MEM_TYPE[1:0]	169, 170	0b00	Select Memory Type for SOC. 0b00: Select SPI flash + DDR-3 0b10: Select SPI flash + DDR-1 0b01: Select SPI flash + DDR-2 0b11: Select EEPROM

Pin Name	Pin No.	Default	Description
CLK_M_EE[1:0]	171, 172	0b00	When MEM_TYPE Select is SPI Flash: This Strapping Pin Selects the Initial Clock for The Memory Controller. For DDR2: 0b00: Reserved for test; 0b01: Reserved for test; 0b10: 100MHz 0b11: Reserved for test; For DDR3: 0b00: Reserved for test; 0b01: Reserved for test; 0b10: 125MHz 0b11: Reserved for test; <i>Note: The initial value for this strapping pin must be set as recommended in the reference design guide.</i> When MEM_TYPE Select is EEPROM: CLK_M_EE[0] is used to select SOC EEPROM address byte size. 0b0: 1-byte address 0b1: 2-byte address
EN_DECRYPT	173	0b0	Enable or Disable Decrypt for Flash. 0b0: Disable decrypt 0b1: Enable decrypt

5.5.12. Miscellaneous Interface Pins

Table 13. Miscellaneous Interface Pins

Pin Name	Pin No.	Type	Drive (mA)	Description
MDC	120	O _{PU}	12	MII Management Interface Clock Pin.
MDIO	121	I/O _{PU}	12	MII Management Interface Data Pin.
SSPI_CLK/I2C_CLK	119	I/O _{PU}	4	SPI Serial Clock Input (Slave Mode). I2C Interface Clock Input (Slave Mode). I2C Interface Clock Output (Master Mode).
SSPI_SI/I2C_DAT	118	I/O _{PU}	4	SPI Serial Data Input (Slave Mode). I2C Interface Bi-Directional data (Slave Mode).
SSPI_SO	117	I/O _{PD}	4	SPI Serial Data Output (Slave Mode).
SSPI_CS#	116	I _{UP}	4	SPI Serial Chip Select (Slave Mode).
RESET#	114	AI	-	System Pin Reset Input (Low Active). To complete the reset function, this pin must be asserted for at least 10ms. It must be pulled up for normal operation.
XI	106	AI	-	25MHz Crystal Clock Input and Feedback Pin.
XO	105	AO	-	25MHz Crystal Clock Output Pin.
MDIREF	21	AO	-	MDI Bias Resistor. Adjust the reference current for all PHYs. This pin must connect to AGND via a 2.49k ohm resistor.
RTT1	23	AI/O	-	Reserved for Internal Use (Must be Left Floating).
RTT2	24	AI/O	-	Reserved for Internal Use (Must be Left Floating).
VX	179	A	-	Low Voltage Power Control Resistor.
CKOUT0	92	AO	8	25MHz Clock Output.
ATESTCK[1:0]	58, 214	AO	-	Reserved for Internal Use (Must be Left Floating).
RESERVED	82, 83, 87, 88, 180, 182, 183, 187, 188	-	-	Reserved pins (Must be Left Floating).

Pin Name	Pin No.	Type	Drive (mA)	Description
TEST[7:0]	84, 85, 89, 90, 184, 185, 189, 190	-	-	Reserved for Testing.

5.5.13. Power and Ground Pins

Table 14. Power and Ground Pins

Pin Name	Pin No.	Type	Description
AVDDL	3, 13, 22, 42, 52, 63, 73, 198, 208	AP	Analog Low Voltage Power.
PLLVDL	57, 213	AP	Analog PLL Low Voltage Power.
AVDDH	8, 14, 19, 25, 36, 41, 47, 68, 78, 193, 203	AP	Analog High Voltage Power.
DVDDL	26, 33, 34, 79, 108, 109, 126, 139, 160, 178, 192	P	Digital Low Voltage Power.
DVDDH	27, 35, 115, 131	P	Digital High Voltage Power.
SVDDL	81, 86, 93, 98, 103, 181, 191	AP	SerDes Low Voltage Power.
AVDDL_PLL	107	AP	PLL Low Voltage Power.
SVDDH	91, 186	AP	SerDes High Voltage Power.
AVDDH_PLL	104	AP	PLL High Voltage Power.
MVDDH	132, 162, 163, 177	P	SDRAM High Voltage Power.
VREF	143	P	SSTL Reference Voltage (MVDDH/2).
AGND	20	AG	Analog Ground.
DGND	E-PAD	G	Digital Ground.

6. Pin Assignments and Description (RTL8382M-VB)

6.1. Pin Assignments Figure (RTL8382M-VB)

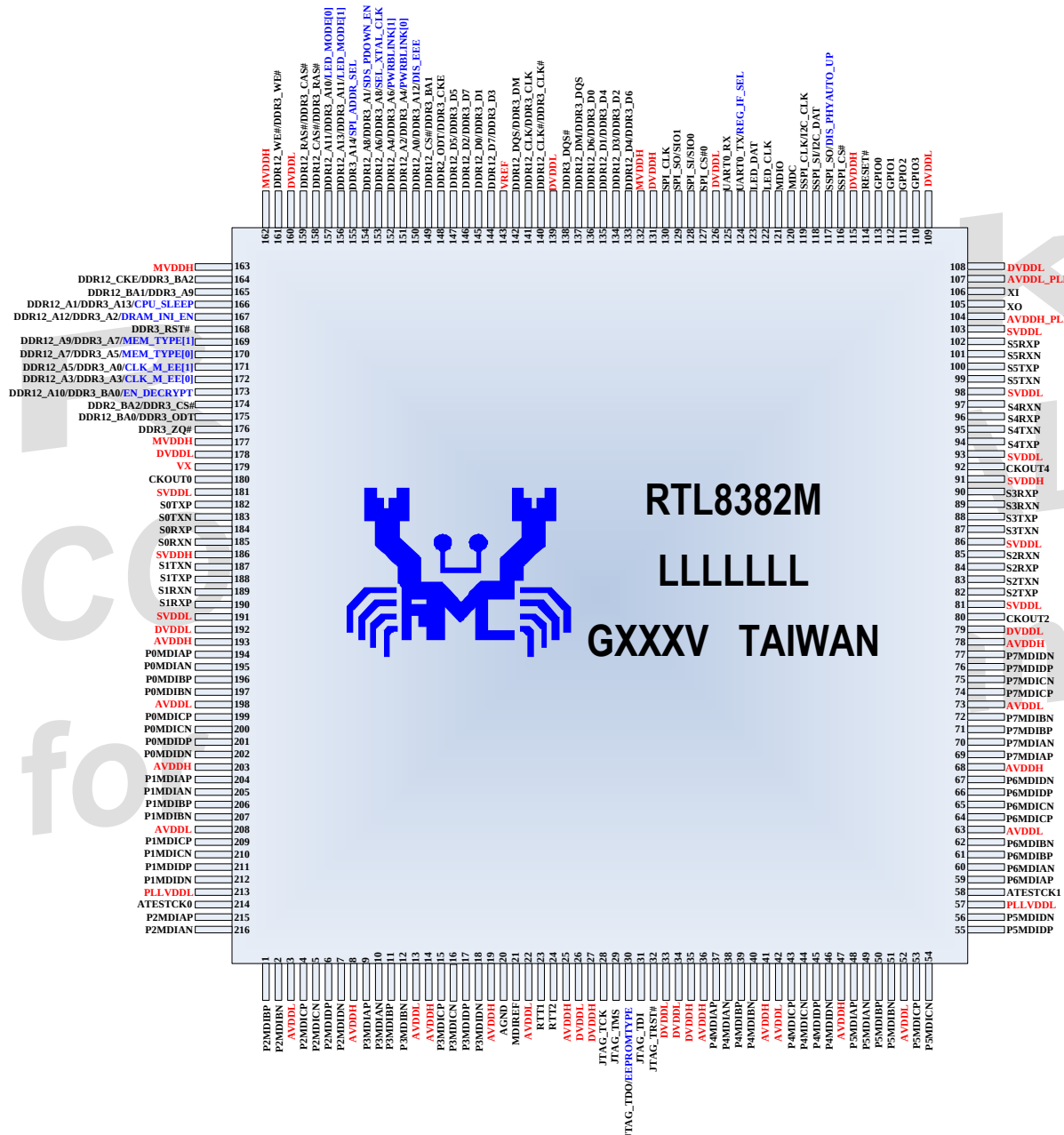


Figure 8. Pin Assignments (RTL8382M-VB)

6.2. Package Identification

Green package is indicated by a 'G' in 'GXXXX' (Figure 8). The version number is shown in the location marked 'v'.

6.3. Pin Assignments Table Codes (RTL8382M-VB)

Upon Reset: Defined as a short time after the end of a hardware reset.

After Reset: Defined as the time after the specified 'Upon Reset' time.

I: Input Pin	AI: Analog Input Pin
O: Output Pin	AO: Analog Output Pin
I/O: Bi-Directional Input/Output Pin	AI/O: Analog Bi-Directional Input/Output Pin
P: Digital Power Pin	AP: Analog Power Pin
G: Digital Ground Pin	AG: Analog Ground Pin
I _{PU} : Input Pin With Pull-Up Resistor; (Typical Value = 75KΩ)	O _{PU} : Output Pin With Pull-Up Resistor; (Typical Value = 75KΩ)
I _{PD} : Input Pin With Pull-Down Resistor; (Typical Value = 75KΩ)	O _{PD} : Output Pin With Pull-Down Resistor; (Typical Value = 75KΩ)

6.4. Pin Assignments Table (RTL8382M-VB)

Table 15. Pin Assignments Table (RTL8382M-VB)

Name	Pin No.	Type	Name	Pin No.	Type
P2MDIBP	1	AI/O	AVDDH	19	AP
P2MDIBN	2	AI/O	AGND	20	AG
AVDDL	3	AP	MDIREF	21	AO
P2MDICP	4	AI/O	AVDDL	22	AP
P2MDICN	5	AI/O	RTT1	23	AI/O
P2MDIDP	6	AI/O	RTT2	24	AI/O
P2MDIDN	7	AI/O	AVDDH	25	AP
AVDDH	8	AP	DVDDL	26	DP
P3MDIAP	9	AI/O	DVDDH	27	DP
P3MDIAN	10	AI/O	JTAG_TCK	28	I/O _{PU}
P3MDIBP	11	AI/O	JTAG_TMS	29	I/O _{PU}
P3MDIBN	12	AI/O	JTAG_TDO/EEPROMTYPE	30	I/O _{PD}
AVDDL	13	AP	JTAG_TDI	31	I/O _{PD}
AVDDH	14	AP	JTAG_TRST#	32	I/O _{PU}
P3MDICP	15	AI/O	DVDDL	33	DP
P3MDICN	16	AI/O	DVDDH	34	DP
P3MDIDP	17	AI/O	AVDDH	35	DP
P3MDIDN	18	AI/O	AVDDH	36	AP

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Datasheet

Name	Pin No.	Type
P4MDIAP	37	AI/O
P4MDIAN	38	AI/O
P4MDIBP	39	AI/O
P4MDIBN	40	AI/O
AVDDH	41	AP
AVDDL	42	AP
P4MDICP	43	AI/O
P4MDICN	44	AI/O
P4MDIDP	45	AI/O
P4MDIDN	46	AI/O
AVDDH	47	AP
P5MDIAP	48	AI/O
P5MDIAN	49	AI/O
P5MDIBP	50	AI/O
P5MDIBN	51	AI/O
AVDDL	52	AP
P5MDICP	53	AI/O
P5MDICN	54	AI/O
P5MDIDP	55	AI/O
P5MDIDN	56	AI/O
PLLVDL	57	AP
ATESTCK1	58	AO
P6MDIAP	59	AI/O
P6MDIAN	60	AI/O
P6MDIBP	61	AI/O
P6MDIBN	62	AI/O
AVDDL	63	AP
P6MDICP	64	AI/O
P6MDICN	65	AI/O
P6MDIDP	66	AI/O
P6MDIDN	67	AI/O
AVDDH	68	AP
P7MDIAP	69	AI/O
P7MDIAN	70	AI/O
P7MDIBP	71	AI/O
P7MDIBN	72	AI/O
AVDDL	73	AP
P7MDICP	74	AI/O
P7MDICN	75	AI/O
P7MDIDP	76	AI/O
P7MDIDN	77	AI/O

Name	Pin No.	Type
AVDDH	78	AP
DVDDL	79	DP
CKOUT2	80	AO
SVDDL	81	AP
S2TXP	82	AO
S2TXN	83	AO
S2RXP	84	AI
S2RXN	85	AI
SVDDL	86	AP
S3TXN	87	AO
S3TXP	88	AO
S3RXN	89	AI
S3RXP	90	AI
SVDDH	91	AP
CKOUT4	92	AO
SVDDL	93	AP
S4TXP	94	AO
S4TXN	95	AO
S4RXP	96	AI
S4RXN	97	AI
SVDDL	98	AP
S5TXN	99	AO
S5TXP	100	AO
S5RXN	101	AI
S5RXP	102	AI
SVDDL	103	AP
AVDDH_PLL	104	AP
XO	105	AO
XI	106	AI
AVDDL_PLL	107	AP
DVDDL	108	P
DVDDL	109	P
GPIO3	110	I/O _{PD}
GPIO2	111	I/O _{PD}
GPIO1	112	I/O _{PD}
GPIO0	113	I/O _{PD}
RESET#	114	AI
DVDDH	115	P
SSPI_CS#	116	I _{PU}
SSPI_SO/ DIS_PHYAUTO_UP	117	I/O _{PD}
SSPI_SI/I2C_DAT	118	I/O _{PU}

Name	Pin No.	Type
SSPI_CLK/I2C_CLK	119	I/O _{PU}
MDC	120	O _{PU}
MDIO	121	I/O _{PU}
LED_CLK	122	O _{PU}
LED_DAT	123	I/O _{PU}
UART0_TX/REG_IF_SEL	124	I/O _{PD}
UART0_RX	125	I _{PD}
DVDDL	126	P
SPI_CS#0	127	O
SPI_SI/SIO0	128	I/O _{PD}
SPI_SO/SIO1	129	I/O _{PD}
SPI_CLK	130	O _{PD}
DVDDH	131	P
MVDDH	132	P
DDR12_D4/DDR3_D6	133	I/O
DDR12_D3/DDR3_D2	134	I/O
DDR12_D1/DDR3_D4	135	I/O
DDR12_D6/DDR3_D0	136	I/O
DDR12_DM/DDR3_DQS	137	I/O
DDR3_DQS#	138	I/O
DVDDL	139	P
DDR12_CLK#/DDR3_CLK#	140	O
DDR12_CLK/DDR3_CLK	141	O
DDR12_DQS/DDR3_DM	142	I/O
VREF	143	P
DDR12_D7/DDR3_D3	144	I/O
DDR12_D0/DDR3_D1	145	I/O
DDR12_D2/DDR3_D7	146	I/O
DDR12_D5/DDR3_D5	147	I/O
DDR2_ODT/DDR3_CKE	148	O
DDR12_CS#/DDR3_BA1	149	O
DDR12_A0/DDR3_A12/ DIS_EEE	150	I/O
DDR12_A2/DDR3_A4/ PWRBLINK[0]	151	I/O
DDR12_A4/DDR3_A6/ PWRBLINK[1]	152	I/O
DDR12_A6/DDR3_A8/ SEL_XTAL_CLK	153	I/O
DDR12_A8/DDR3_A1/ SDS_PDOWN_EN	154	I/O
DDR3_A14/SPI_ADDR_SEL	155	I/O

Name	Pin No.	Type
DDR12_A13/DDR3_A11/ LED/MODE[1]	156	I/O
DDR12_A11/DDR3_A10/ LED/MODE[0]	157	I/O
DDR12_CAS#/DDR3_RAS#	158	O
DDR12_RAS#/DDR3_CAS#	159	O
DVDDL	160	P
DDR12_WE#/DDR3_WE#	161	O
MVDDH	162	P
MVDDH	163	P
DDR12_CKE/DDR3_BA2	164	O
DDR12_BA1/DDR3_A9	165	O
DDR12_A1/DDR3_A13/ CPU_SLEEP	166	I/O
DDR12_A12/DDR3_A2/ DRAM_INI_EN	167	I/O
DDR3_RST#	168	O
DDR12_A9/DDR3_A7/ MEM_TYPE[1]	169	I/O
DDR12_A7/DDR3_A5/ MEM_TYPE[0]	170	I/O
DDR12_A5/DDR3_A0/ CLK_M_EE[1]	171	I/O
DDR12_A3/DDR3_A3/ CLK_M_EE[0]	172	I/O
DDR12_A10/DDR3_BA0/ EN_DECRYPT	173	I/O
DDR2_BA2/DDR3_CS#	174	O
DDR12_BA0/DDR3_ODT	175	O
DDR3_ZQ#	176	-
MVDDH	177	P
DVDDL	178	P
VX	179	A
CKOUT0	180	AO
SVDDL	181	AP
S0TXP	182	AO
S0TXN	183	AO
S0RXP	184	AI
S0RXN	185	AI
SVDDH	186	AP
S1TXN	187	AO
S1TXP	188	AO
S1RXN	189	AI
S1RXP	190	AI

Name	Pin No.	Type
SVDDL	191	AP
DVDDL	192	P
AVDDH	193	AP
P0MDIAP	194	AI/O
P0MDIAN	195	AI/O
P0MDIBP	196	AI/O
P0MDIBN	197	AI/O
AVDDL	198	AP
P0MDICP	199	AI/O
P0MDICN	200	AI/O
P0MDIDP	201	AI/O
P0MDIDN	202	AI/O
AVDDH	203	AP
P1MDIAP	204	AI/O

Name	Pin No.	Type
P1MDIAN	205	AI/O
P1MDIBP	206	AI/O
P1MDIBN	207	AI/O
AVDDL	208	AP
P1MDICP	209	AI/O
P1MDICN	210	AI/O
P1MDIDP	211	AI/O
P1MDIDN	212	AI/O
PLLVDL	213	AP
ATESTCK0	214	AO
P2MDIAP	215	AI/O
P2MDIAN	216	AI/O
DGND	EPAD	G

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6.5. Pin Descriptions (RTL8382M-VB)

6.5.1. 1000M Ethernet PHY MDI Interface Pins

Table 16. 1000M Ethernet PHY MDI Interface Pins

Pin Name	Pin No.	Type	Description
P0MDIAP	194	AI/O	Port 0 Media Dependent Interface A~D. For 1000Base-T operation, differential data from the media is transmitted and received on all four pairs. For 100Base-Tx and 10Base-T operation, only MDIAP/N and MDIBP/N are used. Auto MDIX can reverse the pairs MDIAP/N and MDIBP/N. Each of the differential pairs has an internal 100 ohm termination resistor.
P0MDIAN	195	AI/O	
P0MDIBP	196	AI/O	
P0MDIBN	197	AI/O	
P0MDICP	199	AI/O	
P0MDICN	200	AI/O	
P0MDIDP	201	AI/O	
P0MDIDN	202	AI/O	
P1MDIAP	204	AI/O	Port 1 Media Dependent Interface A~D. For 1000Base-T operation, differential data from the media is transmitted and received on all four pairs. For 100Base-Tx and 10Base-T operation, only MDIAP/N and MDIBP/N are used. Auto MDIX can reverse the pairs MDIAP/N and MDIBP/N. Each of the differential pairs has an internal 100 ohm termination resistor.
P1MDIAN	205	AI/O	
P1MDIBP	206	AI/O	
P1MDIBN	207	AI/O	
P1MDICP	209	AI/O	
P1MDICN	210	AI/O	
P1MDIDP	211	AI/O	
P1MDIDN	212	AI/O	
P2MDIAP	215	AI/O	Port 2 Media Dependent Interface A~D. For 1000Base-T operation, differential data from the media is transmitted and received on all four pairs. For 100Base-Tx and 10Base-T operation, only MDIAP/N and MDIBP/N are used. Auto MDIX can reverse the pairs MDIAP/N and MDIBP/N. Each of the differential pairs has an internal 100 ohm termination resistor.
P2MDIAN	216	AI/O	
P2MDIBP	1	AI/O	
P2MDIBN	2	AI/O	
P2MDICP	4	AI/O	
P2MDICN	5	AI/O	
P2MDIDP	6	AI/O	
P2MDIDN	7	AI/O	
P3MDIAP	9	AI/O	Port 3 Media Dependent Interface A~D. For 1000Base-T operation, differential data from the media is transmitted and received on all four pairs. For 100Base-Tx and 10Base-T operation, only MDIAP/N and MDIBP/N are used. Auto MDIX can reverse the pairs MDIAP/N and MDIBP/N. Each of the differential pairs has an internal 100 ohm termination resistor.
P3MDIAN	10	AI/O	
P3MDIBP	11	AI/O	
P3MDIBN	12	AI/O	
P3MDICP	15	AI/O	
P3MDICN	16	AI/O	
P3MDIDP	17	AI/O	
P3MDIDN	18	AI/O	

Pin Name	Pin No.	Type	Description
P4MDIAP	37	AI/O	Port 4 Media Dependent Interface A~D. For 1000Base-T operation, differential data from the media is transmitted and received on all four pairs. For 100Base-Tx and 10Base-T operation, only MDIAP/N and MDIBP/N are used. Auto MDIX can reverse the pairs MDIAP/N and MDIBP/N. Each of the differential pairs has an internal 100 ohm termination resistor.
P4MDIAN	38	AI/O	
P4MDIBP	39	AI/O	
P4MDIBN	40	AI/O	
P4MDICP	43	AI/O	
P4MDICN	44	AI/O	
P4MDIDP	45	AI/O	
P4MDIDN	46	AI/O	
P5MDIAP	48	AI/O	Port 5 Media Dependent Interface A~D. For 1000Base-T operation, differential data from the media is transmitted and received on all four pairs. For 100Base-Tx and 10Base-T operation, only MDIAP/N and MDIBP/N are used. Auto MDIX can reverse the pairs MDIAP/N and MDIBP/N. Each of the differential pairs has an internal 100 ohm termination resistor.
P5MDIAN	49	AI/O	
P5MDIBP	50	AI/O	
P5MDIBN	51	AI/O	
P5MDICP	53	AI/O	
P5MDICN	54	AI/O	
P5MDIDP	55	AI/O	
P5MDIDN	56	AI/O	
P6MDIAP	59	AI/O	Port 6 Media Dependent Interface A~D. For 1000Base-T operation, differential data from the media is transmitted and received on all four pairs. For 100Base-Tx and 10Base-T operation, only MDIAP/N and MDIBP/N are used. Auto MDIX can reverse the pairs MDIAP/N and MDIBP/N. Each of the differential pairs has an internal 100 ohm termination resistor.
P6MDIAN	60	AI/O	
P6MDIBP	61	AI/O	
P6MDIBN	62	AI/O	
P6MDICP	64	AI/O	
P6MDICN	65	AI/O	
P6MDIDP	66	AI/O	
P6MDIDN	67	AI/O	
P7MDIAP	69	AI/O	Port 7 Media Dependent Interface A~D. For 1000Base-T operation, differential data from the media is transmitted and received on all four pairs. For 100Base-Tx and 10Base-T operation, only MDIAP/N and MDIBP/N are used. Auto MDIX can reverse the pairs MDIAP/N and MDIBP/N. Each of the differential pairs has an internal 100 ohm termination resistor.
P7MDIAN	70	AI/O	
P7MDIBP	71	AI/O	
P7MDIBN	72	AI/O	
P7MDICP	74	AI/O	
P7MDICN	75	AI/O	
P7MDIDP	76	AI/O	
P7MDIDN	77	AI/O	

6.5.2. SGMII Interface Pins

Table 17. SGMII Interface Pins

Pin Name	Pin No.	Type	Description
S4RXP	96	AI	SGMII Interface Receive Data Differential Input Pair.
S4RXN	97	AI	
S4TXP	94	AO	SGMII Interface Transmit Data Differential Output Pair.
S4TXN	95	AO	
S5RXP	102	AI	SGMII Interface Receive Data Differential Input Pair.
S5RXN	101	AI	
S5TXP	100	AO	SGMII Interface Transmit Data Differential Output Pair.
S5TXN	99	AO	

6.5.3. QSGMII Interface Pins

Table 18. QSGMII Interface Pins

Pin Name	Pin No.	Type	Description
S0RXP	184	AI	QSGMII Interface Receive Data Differential Input Pair.
S0RXN	185	AI	
S0TXP	182	AO	QSGMII Interface Transmit Data Differential Output Pair.
S0TXN	183	AO	
S1RXP	190	AI	QSGMII Interface Receive Data Differential Input Pair.
S1RXN	189	AI	
S1TXP	188	AO	QSGMII Interface Transmit Data Differential Output Pair.
S1TXN	187	AO	
S2RXP	84	AI	QSGMII Interface Receive Data Differential Input Pair.
S2RXN	85	AI	
S2TXP	82	AO	QSGMII Interface Transmit Data Differential Output Pair.
S2TXN	83	AO	
S3RXP	90	AI	QSGMII Interface Receive Data Differential Input Pair.
S3RXN	89	AI	
S3TXP	88	AO	QSGMII Interface Transmit Data Differential Output Pair.
S3TXN	87	AO	
S4RXP	96	AI	QSGMII Interface Receive Data Differential Input Pair.
S4RXN	97	AI	
S4TXP	94	AO	QSGMII Interface Transmit Data Differential Output Pair.
S4TXN	95	AO	

6.5.4. 1000Base-X/100Base-FX Interface Pins

Table 19. 1000Base-X/100Base-FX Interface Pins

Pin Name	Pin No.	Type	Description
S4RXP	96	AI	1000Base-X/100Base-FX Interface Receive Data Differential Input Pair.
S4RXN	97	AI	
S4TXP	94	AO	1000Base-X/100Base-FX Interface Transmit Data Differential Output Pair.
S4TXN	95	AO	
S5RXP	102	AI	1000Base-X/100Base-FX Interface Receive Data Differential Input Pair.
S5RXN	101	AI	
S5TXP	100	AO	1000Base-X/100Base-FX Interface Transmit Data Differential Output Pair.
S5TXN	99	AO	

6.5.5. DDR1/2 SDRAM Interface Pins

Table 20. DDR1/2 SDRAM Interface Pins

Pin Name	Pin No.	Type	Drive (mA)	Description
DDR12_D[7:0]	144, 136, 147, 133, 134, 146, 135, 145	I/O	8	DDR SDRAM Data Bus.
DDR12_A[13:0]	156, 167, 157, 173, 169, 154, 170, 153, 171, 152, 172, 151, 166, 150	I/O	8	DDR SDRAM Address Select.
DDR2_BA[2]	174	O	8	DDR SDRAM Bank Address Select.
DDR12_BA[1:0]	165, 175	O	8	DDR SDRAM Bank Address Select.
DDR12_WE#	161	O	8	DDR SDRAM Write Enable.
DDR12_CKE	164	O	8	DDR SDRAM Clock Enable.
DDR12_RAS#	159	O	8	DDR SDRAM Row Address Strobe.
DDR12_CAS#	158	O	8	DDR SDRAM Column Address Strobe.
DDR12_CS#0	149	O	8	DDR SDRAM Chip Select 0.
DDR2_ODT	148	O	8	DDR SDRAM On-Die Termination.
DDR12_DQS	142	I/O	8	DDR SDRAM Data Strobe.
DDR12_CLK	141	O	8	DDR SDRAM Clock. CLK and CLK# are differential clock outputs.
DDR12_CLK#	140	O	8	DDR SDRAM Clock. CLK and CLK# are differential clock outputs.

6.5.6. DDR3 SDRAM Interface Pins

Table 21. DDR3 SDRAM Interface Pins

Pin Name	Pin No.	Type	Drive (mA)	Description
DDR3_D[7:0]	146, 133, 147, 135, 144, 134, 145, 136	I/O	8	DDR SDRAM Data Bus.
DDR3_A[14]	155	O	8	DDR SDRAM Address Select.
DDR3_A[13:10]	166, 150, 156, 157	I/O	8	DDR SDRAM Address Select.
DDR3_A[9]	165	O	8	DDR SDRAM Address Select.
DDR3_A[8:0]	153, 169, 152, 170, 151, 172, 167, 154, 171	I/O	8	DDR SDRAM Address Select.
DDR3_DQS#	138	I/O	8	DDR SDRAM Data Strobe.
DDR3_DQS	137	I/O	8	DDR SDRAM Data Strobe.
DDR3_CLK#	140	O	8	DDR SDRAM Clock.
DDR3_CLK	141	O	8	DDR SDRAM Clock.
DDR3_DM	142	I/O	8	DDR SDRAM Data Mask.
DDR3_CKE	148	O	8	DDR SDRAM Clock Enable.
DDR3_BA[2:1]	164, 149	O	8	DDR SDRAM Bank Address Select.
DDR3_BA[0]	173	I/O	8	DDR SDRAM Bank Address Select.
DDR3_RAS#	158	O	8	DDR SDRAM Row Address Strobe.
DDR3_CAS#	159	O	8	DDR SDRAM Column Address Strobe.
DDR3_WE#	161	O	8	DDR SDRAM Write Enable.
DDR3_RST#	168	O	8	DDR SDRAM Reset.
DDR3_CS#	174	O	8	DDR SDRAM Chip Select.
DDR3_ODT	175	O	8	DDR SDRAM On-Die Termination.
DDR3_ZQ#	176	-	8	DDR SDRAM External Reference Ball for Output Drive Calibration. This ball is tied to an external 240 Ohm resistor, which is tied to GND.

6.5.7. Master Mode SPI Flash Interface Pins

Table 22. Master Mode SPI Flash Interface Pins

Pin Name	Pin No.	Type	Drive (mA)	Description
SPI_CLK	130	O _{PD}	12	Serial Clock Output Pin.
SPI_SO/SIO1	129	I/O _{PD}	12	In Serial Mode: This is a flash chip output pin In Dual Mode: This is a flash chip bi-directional pin <i>Note: This is MSB first.</i>
SPI_SI/SIO0	128	I/O _{PD}	12	In Serial Mode: This is a flash chip input pin In Dual Mode: This is a flash chip bi-directional pin <i>Note: This is LSB first.</i>
SPI_CS#0	127	O	12	Chip Select Output Pin. Slave Transmit Enable and active low.

6.5.8. UART Interface Pins

Table 23. UART Interface Pins

Pin Name	Pin No.	Type	Drive (mA)	Description
UART0_RX	125	I _{PD}	4	UART0 Interface Receive Data.
UART0_TX	124	I/O _{PD}	4	UART0 Interface Transmit Data.
UART1_RX	116	I _{PU}	4	UART1 Interface Receive Data.
UART1_TX	117	I/O _{PD}	4	UART1 Interface Transmit Data.

6.5.9. LED Interface Pins

Table 24. LED Interface Pins

Pin Name	Pin No.	Type	Drive (mA)	Description
LED_CLK	122	O _{PU}	12	(1) In Serial LED Mode Reference output clock for serial LED interface and Data is latched on the rising of LEDCK. (2) In SMI-like LED Mode Reference output clock for I2C-like interface.
LED_DAT	123	I/O _{PU}	12	(1) In Serial LED Mode Serial bit stream of link status information. (2) In I2C-like LED Mode The data written to the LED IC.

6.5.10. GPIO Interface Pins

Table 25. GPIO Interface Pins

Pin Name	Pin No.	Type	Drive (mA)	Description
GPIO0	113	I/O _{PD}	4	This pin default set as system LED. Can be configured as General Purpose Input/Output Pin.
GPIO[3:1]	110, 111, 112	I/O _{PD}	4	General Purpose Input/Output Pins.
GPO10	30	I/O _{PD}	4	General Purpose Output Pins.
GPIO11	31	I/O _{PD}	4	General Purpose Input/Output Pins.
GPIO[14:12]	32,28,29	I/O _{PU}	4	General Purpose Input/Output Pins.

6.5.11. EJTAG Interface Pins

Table 26. EJTAG Interface Pins

Pin Name	Pin No.	Type	Drive (mA)	Description
JTAG_TMS	29	I/O _{PU}	4	JTAG Test Mode Select.
JTAG_TCK	28	I/O _{PU}	4	JTAG Test Clock Input.
JTAG_TRST#	32	I/O _{PU}	4	JTAG Test Reset.
JTAG_TDI	31	I/O _{PD}	4	JTAG Test Data Input.
JTAG_TDO	30	I/O _{PD}	4	JTAG Test Data Output.

6.5.12. Configuration Strapping Pins

Table 27. Configuration Strapping Pins

Pin Name	Pin No.	Default	Description
EEPROMTYPE	30	0b0	Select EEPROM Address Byte Size. 0b0: 1-byte 0b1: 2-byte
DIS_PHYAUTO_UP	117	0b0	Disable ASIC Auto Power Up PHY. 0b0: Enable ASIC auto power up PHY 0b1: Disable ASIC auto power up PHY
REG_IF_SEL	124	0b0	Select Switch Core Register Access Interface. 0b0: I2C 0b1: SPI slave
DIS_EEE	150	0b0	Disable 1000M EEE and 100M EEE Function. 0b0: Enable 0b1: Disable
PWRBLINK[1:0]	152, 151	0b00	Select LED Power On Blinking Timer. 0b00: Disable 0b01: 800ms 0b10: 1.6s 0b11: 3.2s
SEL_XTAL_CLK	153	0b0	Select XTAL Input is 25M or 125M. 0b0: 25M 0b1: 125M <i>Note: This option is only for sync Ethernet.</i>
SDS_PDOWN_EN	154	0b0	Enable SerDes Power Down Mode. 0b0: SerDes4/5 operate in normal mode 0b1: SerDes4/5 operate in power down mode
SPI_ADDR_SEL	155	0b0	Select Address Mode for SPI Flash. 0b0: 3-byte address 0b1: 4-byte address
LED_MODE[1:0]	156, 157	0b0	Select LED Mode. 0b00: Serial LED mode 0b01: Scan Single mode 0b10: Scan Bicolor mode 0b11: Disable LED
CPU_SLEEP	166	0b0	Enable CPU Function. 0b0: CPU is always under reset state 0b1: CPU is enabled
DRAM_INI_EN	167	0b0	Enable DRAM Initialization Procedure. 0b0: Enable DRAM Initialization procedure 0b1: Bypass DRAM Initialization procedure
MEM_TYPE[1:0]	169, 170	0b00	Select Memory Type for SOC. 0b00: Select SPI flash + DDR-3 0b01: Select SPI flash + DDR-2 0b10: Select SPI flash + DDR-1 0b11: Select EEPROM

Pin Name	Pin No.	Default	Description
CLK_M_EE[1:0]	171, 172	0b00	When MEM_TYPE Select is SPI Flash: This Strapping Pin Selects the Initial Clock for The Memory Controller. For DDR2: 0b00: Reserved for test; 0b01: Reserved for test; 0b10: 100MHz 0b11: Reserved for test; For DDR3: 0b00: Reserved for test; 0b01: Reserved for test; 0b10: 125MHz 0b11: Reserved for test; <i>Note: The initial value for this strapping pin must be set as recommended in the reference design guide.</i> When MEM_TYPE Select is EEPROM: CLK_M_EE[0] is used to select SOC EEPROM address byte size. 0b0: 1-byte address 0b1: 2-byte address
EN_DECRYPT	173	0b0	Enable or Disable Decrypt for Flash. 0b0: Disable decrypt 0b1: Enable decrypt

6.5.13. Miscellaneous Interface Pins

Table 28. Miscellaneous Interface Pins

Pin Name	Pin No.	Type	Drive (mA)	Description
MDC	120	O _{PU}	12	MII Management Interface Clock Pin.
MDIO	121	I/O _{PU}	12	MII Management Interface Data Pin.
SSPI_CLK/I2C_CLK	119	I/O _{PU}	4	SPI Serial Clock Input (Slave Mode). I2C Interface Clock Input (Slave Mode). I2C Interface Clock Output (Master Mode).
SSPI_SI/I2C_DAT	118	I/O _{PU}	4	SPI Serial Data Input (Slave Mode). I2C Interface Bi-Directional data (Slave Mode).
SSPI_SO	117	I/O _{PD}	4	SPI Serial Data Output (Slave Mode).
SSPI_CS#	116	I _{UP}	4	SPI Serial Chip Select (Slave Mode).
RESET#	114	AI	-	System Pin Reset Input (Low Active). To complete the reset function, this pin must be asserted for at least 10ms. It must be pulled up for normal operation.
XI	106	AI	-	25MHz Crystal Clock Input and Feedback Pin.
XO	105	AO	-	25MHz Crystal Clock Output Pin.
MDIREF	21	AO	-	MDI Bias Resistor. Adjust the reference current for all PHYs. This pin must connect to AGND via a 2.49k ohm resistor.
RTT1	23	AI/O	-	Reserved for Internal Use (Must be Left Floating).
RTT2	24	AI/O	-	Reserved for Internal Use (Must be Left Floating).
VX	179	A	-	Low Voltage Power Control Resistor.
CKOUT0	180	AO	8	25MHz Clock Output.
CKOUT2	80	AO	8	25MHz Clock Output.

Pin Name	Pin No.	Type	Drive (mA)	Description
CKOUT4	92	AO	8	25MHz Clock Output.
ATESTCK[1:0]	58, 214	AO	-	Reserved for Internal Use (Must be Left Floating).

6.5.14. Power and Ground Pins

Table 29. Power and Ground Pins

Pin Name	Pin No.	Type	Description
AVDDL	3, 13, 22, 42, 52, 63, 73, 198, 208	AP	Analog Low Voltage Power.
PLLVDL	57, 213	AP	Analog PLL Low Voltage Power.
AVDDH	8, 14, 19, 25, 36, 41, 47, 68, 78, 193, 203	AP	Analog High Voltage Power.
DVDDL	26, 33, 34, 79, 108, 109, 126, 139, 160, 178, 192	P	Digital Low Voltage Power.
DVDDH	27, 35, 115, 131	P	Digital High Voltage Power.
SVDDL	81, 86, 93, 98, 103, 181, 191	AP	SerDes Low Voltage Power.
AVDDL_PLL	107	AP	PLL Low Voltage Power.
SVDDH	91, 186	AP	SerDes High Voltage Power.
AVDDH_PLL	104	AP	PLL High Voltage Power.
MVDDH	132, 162, 163, 177	P	SDRAM High Voltage Power.
VREF	143	P	SSTL Reference Voltage (MVDDH/2).
AGND	20	AG	Analog Ground.
DGND	E-PAD	G	Digital Ground.

7. Switch Function Description

7.1. *Hardware Reset and Software Reset*

7.1.1. Hardware Reset

A hardware reset forces the RTL8380M-VB/RTL8382M-VB to start the initial power-on sequence. First hardware will strap pins to give all default values when the 'RESET' signal terminates. Next the complete SRAM BIST (Built-In Self Test) process is run. Finally the packet buffer descriptors are initialized and internal registers and external CPU will access them.

7.1.2. Software Reset

The RTL8380M-VB/RTL8382M-VB supports software queue resets, CPU&Memory reset, and Switch NIC reset. Reset sources are the signals that will trigger the reset command to the chip.

- CPU&Memory Reset: Resets MIPS 4KEc + Memory Controller + Peripheral + NIC
- Switch NIC Reset: Resets the NIC interface between the CPU and Switch

7.2. Crystal

The RTL8380M-VB/RTL8382M-VB clock input frequency is 25MHz. When using a crystal, connect a loading capacitor from XI and XO to ground. The maximum Frequency Tolerance is +/-50ppm. Duty cycle should range from 40%~60%.

7.3. IEEE 802.3az Energy Efficient Ethernet (EEE)

The RTL8380M-VB/RTL8382M-VB supports IEEE 802.3az Energy Efficient Ethernet (EEE) for 1000Base-T, 100Base-TX in full duplex operation. The Energy Efficient Ethernet (EEE) operational mode combines the IEEE 802.3 Media Access Control (MAC) Sub-layer with a family of Physical Layers defined to support operation in Low Power Idle (LPI) Mode. When Low Power Idle Mode is enabled, systems on both sides of the link can disable portions of the functionality and save power during periods of low link utilization.

The RTL8380M-VB/RTL8382M-VB EEE operational mode supports IEEE 802.3 MAC operation at 1000Mbps/100Mbps. For 1000Mbps/100Mbps operation, the 1000Base-T/ 100Base-TX PHY is supported.

7.4. Layer 2 Learning and Forwarding

The RTL8380M-VB/RTL8382M-VB has a 4K-entry VLAN table and provides a 64-entry filtering database.

The RTL8380M-VB/RTL8382M-VB supports IVL (Individual VLAN Learning) and SVL (Shared VLAN learning) mode. The mode used depends on the FID (Filtering Identifier) setting.

7.4.1. Forwarding

IP multicast data packets involve multicast group table lookup and forwarding operations. If the table lookup returns a hit, the data packet is forwarded to all member ports and router ports. If the multicast address is not stored in the address table (i.e., lookup miss), the packet is broadcast to all ports of the broadcast domain. The VLAN Frame Forwarding Rules are defined as follows:

- The received broadcast/multicast frame will flood to VLAN member ports only, except for the source port
- The received unicast frame will be forwarded to its destination port only if the destination port is in the same VLAN as the source port. If the destination port belongs to a different VLAN, the frame will be discarded

7.4.2. Learning

The RTL8380M-VB/RTL8382M-VB features a Layer 2 table (8K entries) that uses a 4-way hash structure to store L2 entries. Each entry can be recorded in three formats, L2 Unicast, L2 Multicast, and IP Multicast.

The L2 Unicast hash key is {MAC(48bits), FID/VID(12bits)}; the Multicast hash key is {MAC(48bits), FID/VID(12bits)}; the IP Multicast hash key is {MAC(48bits), FID/VID(12bits)}, {GIP(32bits), SIP(32bits)} or {0(16bits)+GIP(32bits), FID/VID(12bits)}.

7.4.3. DA/SA Block

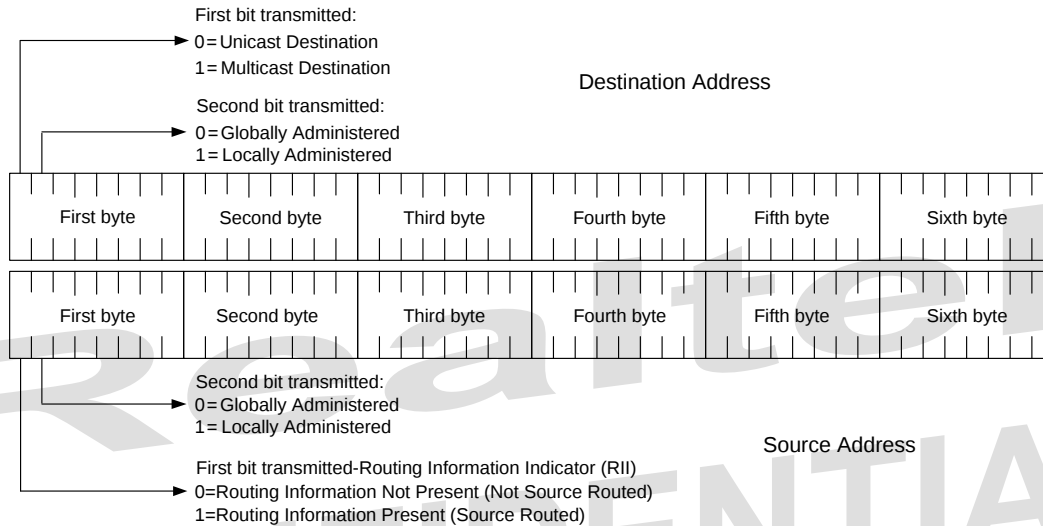


Figure 9. DA/SA Block

While a frame may be sent to either a unicast or a multicast destination, frames are always sent from an individual station. The first bit of the Destination Address shows unicast or multicast. When used in its originally intended manner, the first bit of a Source Address should always be 0, indicating an individual sending station.

The RTL8380M-VB/RTL8382M-VB features DA blocking, SA blocking, or DA and SA blocking function through the Address Hash Table setting.

7.5. Port Isolation

The RTL8380M-VB/RTL8382M-VB supports the Port Isolation feature. We can control whether the hosts communicate with each other or not by controlling a register value.

If we set the register to cut the connection between hosts, all packets from a host cannot be transmitted to another host directly. These packets can only be transmitted by passing through the router. This feature is called 'Port Isolation'. In Figure 10, Host A and host B connect to the port0 and port3 of the switch, respectively, and port7 is a router. If we set the port isolation enable bit of port0 and port3 to 1, all packets between A and B need to pass through the router (in both directions, A to B and B to A).

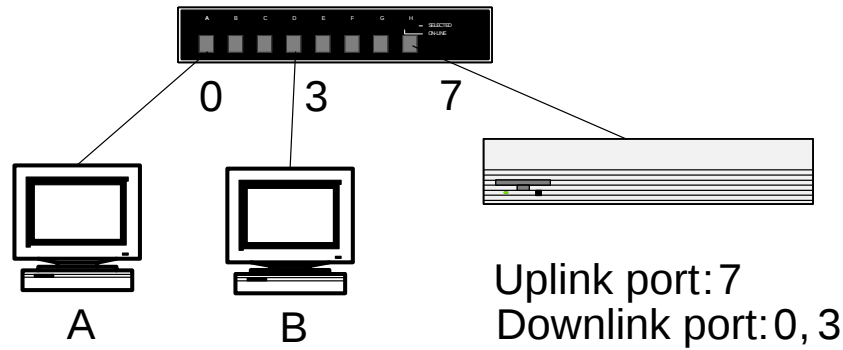


Figure 10. Port Isolation Example

Each port has its own port mask configuration (11 bits in total for the RTL8380M-VB, 29 bits for the RTL8382M-VB). These bits and the TX port list will be mixed to a list. We call this mixed list the final TX port list.

Port isolation port mask settings will affect received packets; however, the Mirroring function is not affected by the port isolation port mask.

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7.6. IEEE 802.3x Flow Control

The RTL8380M-VB/RTL8382M-VB supports IEEE 802.3x full duplex flow control. If one port's received frame buffer is over the pause threshold, a pause-on frame is sent to indicate to the link partner to stop the transmission. When the port's received frame buffer drops below the pause threshold, it sends a pause-off frame. The TX pause frame format is shown in Figure 11.

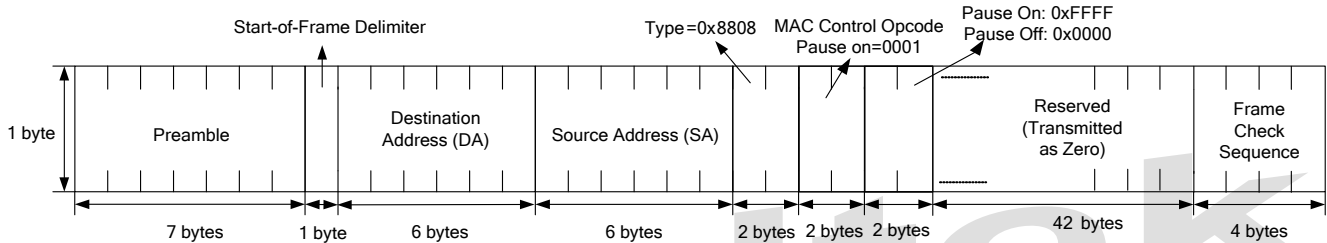


Figure 11. TX Pause Frame Format

The flow control mechanism of the RTL8380M-VB/RTL8382M-VB is implemented on the RX side. It counts the received pages on the RX side in order to determine on which port it should send out Pause On/Off packets.

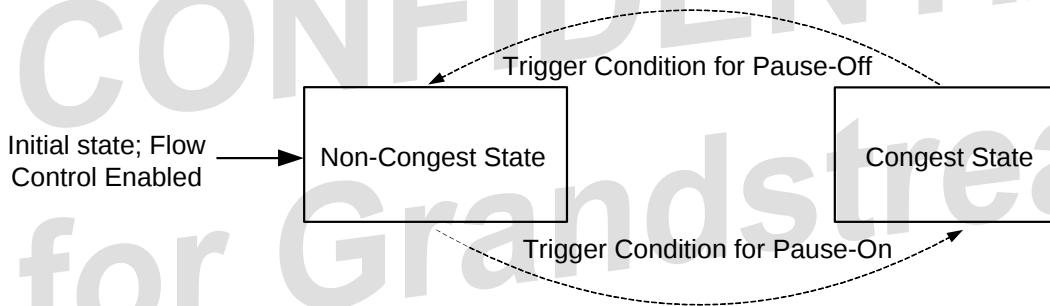


Figure 12. Flow Control State Machine

When RTL8380M-VB/RTL8382M-VB flow control is enabled, the initial state is 'Non_Congest'. The state is monitored continuously. If a pause-on trigger condition occurs, it enters the 'Congest' state. When in the 'congest' state, it is also continuously monitored. When a pause-off trigger condition occurs it re-enters the 'Non_Congest' state. Figure 12 shows the flow control state machine.

7.7. Half Duplex Backpressure

There are two mechanisms for half duplex backpressure (Backpressure is for input buffer overflow).

7.7.1. Collision-Based Backpressure (Jam Mode)

If the input buffer is ready to overflow, this mechanism will force a collision. When the link partner detects this collision, the transmission is rescheduled.

The Reschedule procedure is:

- When the link partner detects the collision, it waits for a random backoff time. The RTL8380M-VB/RTL8382M-VB will handle packets that are in the input packet buffer during this time
- RXDV and TXEN will be driven high. The RTL8380M-VB/RTL8382M-VB will send a 12-byte Jam signal (pattern is preamble (7bytes) + SFD (1byte) + 0xAA (4bytes)). The RTL8380M-VB/RTL8382M-VB will then drive TXEN low
- When the link partner (which could be another RTL8380M-VB/RTL8382M-VB) receives the Jam signal, it will feedback a 4-byte signal (pattern is derived from the CRC of all transmitted bytes)
- After the RTL8380M-VB/RTL8382M-VB receives this jamming signal, it drives RXDV low. The link partner waits for a random backoff time then re-sends the packet. The timing is shown in Figure 13

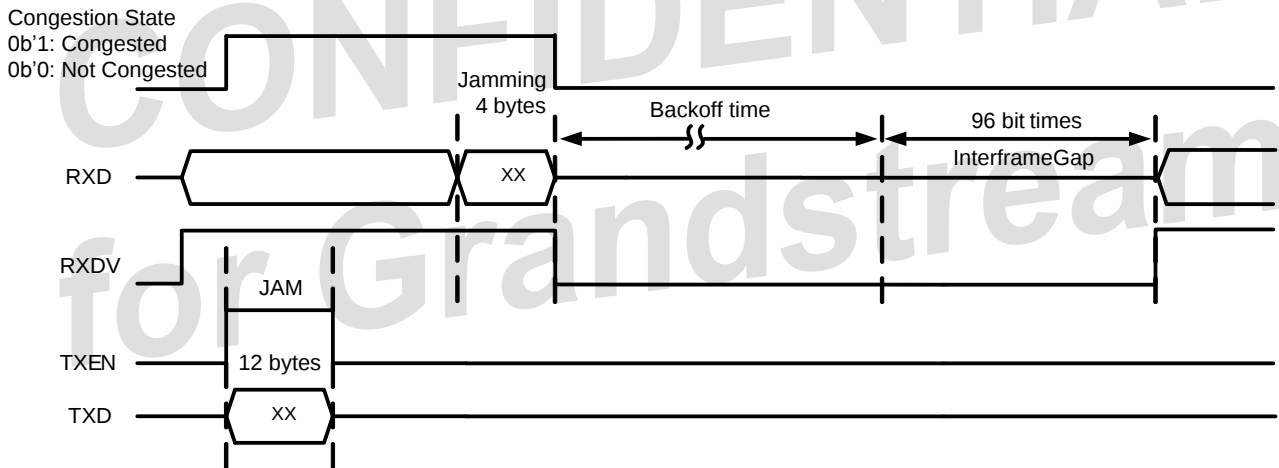


Figure 13. Signal Timing for Collision-Based Backpressure

7.7.2. Carrier-Based Backpressure (I.e., Defer Mode)

If the input buffer is about to overflow, this mechanism will send a fix pattern to defer the other station's transmission. The RTL8380M-VB/RTL8382M-VB will continuously send the defer signal until the input buffer overflow is resolved.

7.8. Layer 2 Multicast and IP Multicast

There are two RTL8380M-VB/RTL8382M-VB IP multicast frame types: IPv4 multicast and IPv6 multicast.

An IPv4 multicast frame must satisfy two conditions:

- The type must be IPv4
- DMAC should=01-00-5E-XX-XX-XX

An IPv6 multicast frame must satisfy two conditions:

- The type must be IPv6
- DMAC should=0x33-33-XX-XX-XX-XX

The RTL8380M-VB/RTL8382M-VB definition of a L2 multicast packet is that the packet is not an IP multicast packet, and the I/G bit of the MAC address is 1.

The RTL8380M-VB/RTL8382M-VB supports IGMPv1/2/3. IGMP and MLDv1/2 packets can be trapped to the CPU to allow software to insert an IP multicast entry into the L2 table.

7.9. IEEE 802.1d/1w/1s (STP/RSTP/MSTP)

There are 64 spanning tree instances for the RTL8380M-VB/RTL8382M-VB. The CPU will create a different Port State for different spanning tree instances at each port.

The RTL8380M-VB/RTL8382M-VB will assign a VID for a received packet, and will look up the VLAN table to check for Multiple Spanning Tree Instances (MSTI).

The RTL8380M-VB/RTL8382M-VB will follow the ports MSTI state to complete its corresponding ingress/egress check. The Spanning Tree and Rapid Spanning Tree port states are shown in Figure 14.

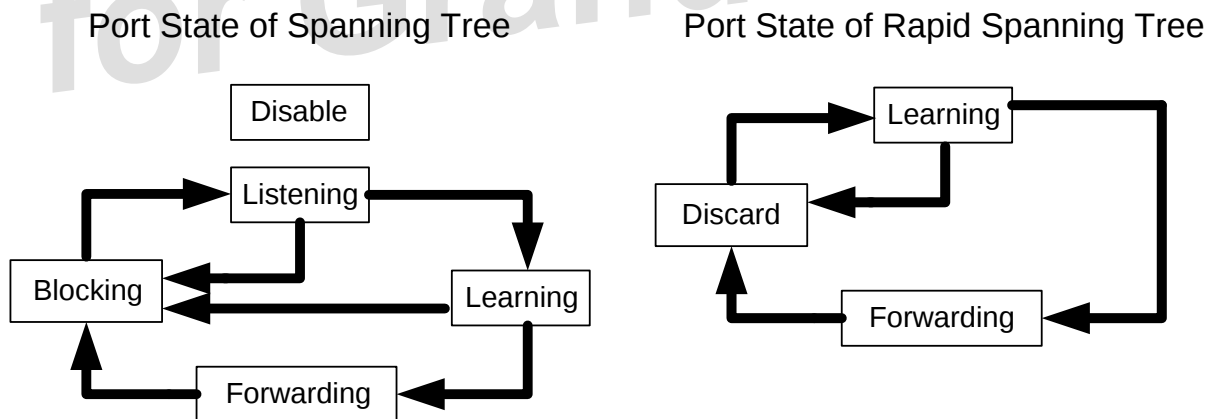


Figure 14. Spanning Tree and Rapid Spanning Tree Port States

When using IEEE 802.1D, the RTL8380M-VB/RTL8382M-VB supports four status' for each port:

Disabled

Except for software forwarding, the port will not transmit/receive packets, and will not perform learning.

Blocking/Listening

Except for software forwarding, the port will only receive BPDU spanning tree protocol packets, but will not transmit any packets, and will not perform learning.

Learning

The port will receive any packet, including BPDU spanning tree protocol packets, and will perform learning, but will only transmit BPDU spanning tree protocol packets.

Forwarding

The port will transmit/receive all packets, and will perform learning.

There are five Spanning Tree port states, and four Rapid Spanning Tree port states. Their mapping relations are Discarding→Blocking, Learning→Learning, and Forwarding→Forwarding (see Table 30).

Table 30. Spanning Tree and Rapid Spanning Tree Action

	Spanning Tree					Rapid Spanning Tree		
	Disable	Blocking	Listening	Learning	Forwarding	Discard	Learning	Forwarding
Receive BPDUs	No	Yes	Yes	Yes	Yes	Yes	Yes	Yes
Transmit BPDUs	No	No	Yes	Yes	Yes	No	Yes	Yes
Learn Address	No	No	No	Yes	Yes	No	Yes	Yes
Forward Frame	No	No	No	No	Yes	No	No	Yes

7.10. IEEE 802.1p and IEEE 802.1Q (VLAN)

The RTL8380M-VB/RTL8382M-VB supports IEEE 802.1Q tag-based, protocol-and-port-based, port-based, MAC-based, IP-subnet-based, and application-based VLANs. It supports a 4K-entry VLAN table, supporting C-VID (Customer VLAN ID) and FID (Filtering Identifier) entries. There are 6 fields in the VLAN table, and their definitions are as below.

- MBR: Determines whether the packets belong to the same VLAN
- UNTAG: Determines whether Egress packets have a VLAN tag
- FID_MSTI: Gets different FIDs (Filtering Identifier) or determines the index of multiple spanning tree instances from different VLANs
- L2_HKEY_UBCAST: Determines the hash key (VID or FID) for L2 unicast and broadcast traffic
- L2_HKEY_MCAST: Determines the hash key (VID or FID) for L2 multicast and IP multicast traffic
- VLAN_PROFILE: Determines the index of the VLAN profile

The RTL8380M-VB/RTL8382M-VB supports eight global VLAN profiles. Each VLAN profile has the following configurations:

- L2_LRN_EN: Enable L2 SA learning
- L2_UNKN_MC_FLD_PMSK: Unknown L2 multicast flooding port mask
- IP4_UNKN_MC_FLD_PMSK: Unknown IPv4 multicast flooding port mask
- IP6_UNKN_MC_FLD_PMSK: Unknown IPv6 multicast flooding port mask

For un-managed switches, there is a register setting to disable tag-based VLANs and force 'no check' for any VLAN settings. If a packet is tagged in, then it is tagged out. If untagged in, then it is untagged out.

- The RTL8380M-VB/RTL8382M-VB supports ingress and egress VLAN filtering functions
- Ingress VLAN filtering: Packets from an input port that is not in the VLAN member set will be dropped, trapped, or forwarded depending on register configuration
- Egress VLAN filtering: Packets to an output port that is not in the VLAN member set will be dropped, trapped, or forwarded depending on register configuration

7.11. IEEE 802.1X (Network Access Control)

The RTL8380M-VB/RTL8382M-VB provides a software solution for 802.1X.

When a host connects to a switch, the switch will transfer the host information to an authentication server:

- If authentication is successful, the switch will set the control bit of this port to 'TRUE' (i.e., the host will be allowed the service)
- If authentication is not successful, the switch will deny the host access to the network

The CPU port can be regarded as a special port where transmit and receive packets are unrestricted for 802.1X.

The RTL8380M-VB/RTL8382M-VB supports two types of 802.1X; Port-Based Network Access Control, and MAC-Based Network Access Control.

- Port-Based Network Access Control: For each port, there is a bit to check whether this port has passed authentication or not. A direction control register decides whether this port needs pass-through authentication for both (IN/OUT) directions or only for receive (IN)
- MAC-Based Access Control: Provides authentication for multiple logical ports. Each logical port represents a source MAC address. There are multiple logical ports for a physical port. There is a register that enables/disables each logical port MAC-based network access control function. Another register controls transmit/receive direction authentication for each port (IN/OUT) or only receive direction (IN)

Table 31 illustrates the forwarding of host n.

Table 31. Forwarding of Host n

Authentication of Host n	Direction of Whole Chip	Fwd Frames to Host n	Fwd Frames from Host n
0 (Unauthorized)	0 (BOTH)	No	No
0 (Unauthorized)	1 (IN)	Yes	No
1 (Authorized)	0 (BOTH)	Yes	Yes
1 (Authorized)	1 (IN)	Yes	Yes

7.12. Reserved Multicast Address Handling

There are some Reserved Multicast Address (RMA) definitions in the IEEE 802.1 standard. The RTL8380M-VB/RTL8382M-VB includes 01-80-C2-00-00-00 to 01-80-C2-00-00-2F RMA support and provides user defined RMA settings. For each RMA, the actions include: Table lookup, Drop, Trap to CPU, and always Flood. The action priority is higher than the results of a L2 Table lookup. Default actions are shown in Table 32.

Table 32. Reserved Multicast Address Default Actions

Name	Address	Default
Bridge Group Address	01-80-C2-00-00-00	Forward
IEEE Std 802.3, 1988 Edition, Full Duplex PAUSE Operation	01-80-C2-00-00-01	Drop
IEEE Std 802.3ad Slow Protocols-Multicast Address	01-80-C2-00-00-02	Drop
IEEE Std 802.1X PAE Address	01-80-C2-00-00-03	Forward
Reserved for future protocol standards	01-80-C2-00-00-04 to 01-80-C2-00-00-0D, 01-80-C2-00-00-0F	Drop
LLDP IEEE Std 802.1AB Link Layer Discovery Protocol Multicast Address	01-80-C2-00-00-0E	Forward
All LANs Bridge Management Group Address	01-80-C2-00-00-10	Drop
GMRP	01-80-C2-00-00-20	Drop
GVRP	01-80-C2-00-00-21	Forward
Reserved for use by Multiple Registration Protocol (MRP) applications	01-80-C2-00-00-22 to 01-80-C2-00-00-2F	Drop

7.13. Layer 2 Traffic Suppression (Storm Control)

The per-port L2 storm filtering control mechanism suppresses the flow rate of some specific packets. The RTL8380M-VB/RTL8382M-VB supports five control types: Unknown Unicast Storm, Unicast Storm, Unknown Multicast Storm, Multicast Storm, and Broadcast Storm. Each port has control registers to enable or disable the storm filtering function. These five traffic type definitions are:

- Unknown Unicast: If the I/G bit of the packet's destination address is 0, it is a unicast packet and its DA look-up in the L2 unicast table failed. I.e., the packet's destination address is unknown
- Unicast: The unicast storm filtering control includes unknown and known unicast for RTL8380M-VB/RTL8382M-VB
- Unknown Multicast: If the I/G bit of the packet's destination address is 1, it is a multicast packet and its DA look-up in the L2 unicast table failed, i.e., the packet's destination address is unknown
- Multicast: The multicast storm filtering control includes unknown and known multicast for RTL8380M-VB/RTL8382M-VB
- Broadcast: DMAC = FF-FF-FF-FF-FF-FF indicates this is a broadcast packet

Unknown Unicast and Unicast use the same traffic counter, and Unknown Multicast and Multicast use the same traffic counter. The user should set the Unicast and Multicast storm type as unknown or both known and unknown in the storm filter setting.

The traffic rate for these five types can be set on a per-port basis. The priority sequence of L2 filtering control is:

1. Input bandwidth control
2. ACL policy
3. Storm-filtering control

7.14. PIE (Packet Inspection Engine)

PIE is a 1.5K-entry search engine that is divided into 12 blocks (block numbers are 0~11). Each block size is 128-entries. Every entry has 216-bit data, and a 216-bit mask. There is an extra bit to indicate whether this entry is valid or not. Each block can be disabled for power saving when it is not used. All the entries are prepared for ingress ACL.

7.14.1. Ingress ACL

The Ingress ACL (Access Control List) perform actions such as packet drop, forwarding, ingress I-VID Assignment, Ingress O-VID Assignment, filter, log, remarking, meter, mirror etc. When a packet hits one entry it will execute the corresponding action mapped to this entry. Each PIE memory entry corresponds to one action entry. The packet can match to multi-actions. When a multi-match occurs (i.e., there are several ACL entries that match) in one block, it will execute the lowest address entry corresponding action.

7.15. Input Bandwidth Control and ACL Traffic Meter

7.15.1. Input Bandwidth Control

The RTL8380M-VB/RTL8382M-VB has input bandwidth control for each port (excluding the CPU port). The bandwidth setting range is 16Kbps~1Gbps. The granularity is 16Kbps, and each port has a 16-bit register to control the bandwidth. If the speed of received packets is faster than the bandwidth setting, it will send a 'Pause ON' packet to slow the link partner transmissions when the flow control function is enabled, and drop packets when the flow control function is disabled. When normal transmissions become possible and the flow control function is enabled, the switch will send a 'Pause OFF' packet.

7.15.2. ACL Traffic Meter

For Ingress ACL entry, there is an index to point to 256 ACL rate-limited entries. The rate limit is flow controlled via leaky bucket. The rate range is 16Kbps~1Gbps, the granularity is 16Kbps, and each rate-limited entry has a 16-bit register to control the rate value.

7.16. IEEE 802.3ad Link Aggregation Protocol

To ensure correct frame ordering when changing the hash algorithm, the marker protocol mechanism must be started. Software will wait for the aggregation port queues to empty, and then send a marker message to all aggregation ports. After receiving a marker reply packet, software can change the hash algorithm.

The RTL8380M-VB/RTL8382M-VB supports 802.3ad (Link Aggregation) for 8 groups of link aggregators with up to 8 ports per-group (based on DMAC/SMAC/SPA/SIP/DIP/SPORT/DPORT). The CPU port cannot be aggregated to an aggregation port. As the RTL8380M-VB/RTL8382M-VB does not check CPU port aggregation, software should check this to avoid frame transmit errors.

Frame Distribution

Link aggregation group frames are sent to an aggregation port of the link aggregation group according to a hash algorithm. There are seven parameters (DMAC, SMAC, SPA, SIP, DIP, SPORT, DPROT). To prevent assigning the same hash value when hash keys simultaneously change to another value, we stagger the least significant bit of all hash keys.

Mapping a Physical Port to a Logical Port

No matter how many physical aggregation port members are in a link aggregation group, it is regarded as one logical port. Each link aggregation has an ID (the lowest number of the physical aggregation port members is used as its ID). Once the ID is chosen, even if the logical port ID's corresponding physical port is link down, the ID and setting of the link aggregation group will not change. However, it will change when this corresponding port is removed or a lower-numbered port is added.

Hash Algorithm Change

The algorithm will change when the following conditions occur:

- The link aggregation group member port changes to link-down or link-up
- The user/LACP (i.e., Link Aggregation Control Protocol) changes the link aggregation group member

port or register setting

7.17. IEEE 802.1ad VLAN Stacking

The RTL8380M-VB/RTL8382M-VB supports multi-layered VLANs and can have Outer-VLAN and Inner-VLAN tagging. Standard 802.1ad takes the S-tag (Service VLAN tag) as the relay VID. The RTL8380M-VB/RTL8382M-VB uses the Outer-tag as S-tag, and the Inner-tag as C-tag to support 802.1ad applications.

The IEEE 802.1ad frame format is shown in Figure 15.

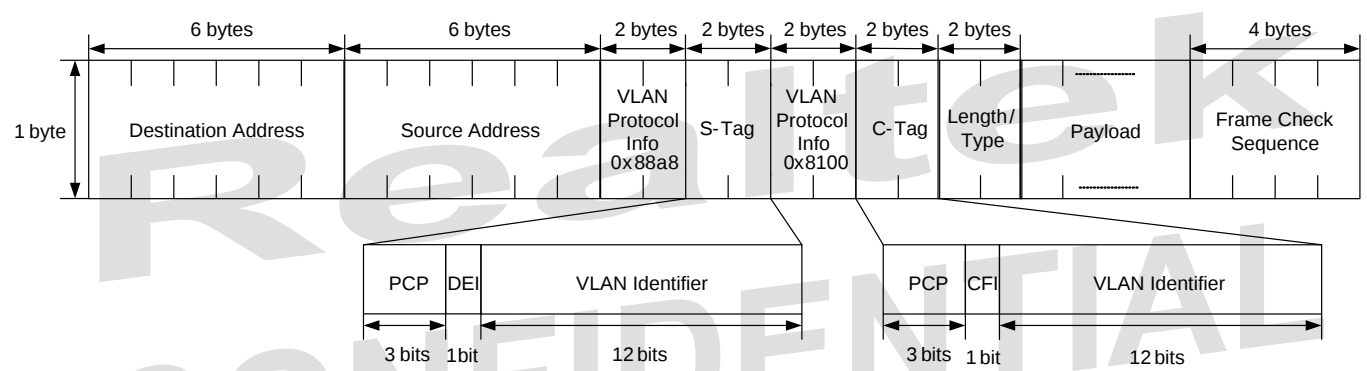


Figure 15. IEEE 802.1ad Frame Format

7.18. Quality of Service (QoS)

There are 5 types of Priority Assignment for the RTL8380M-VB/RTL8382M-VB:

- Port-based Inner-tag Priority
- Port-based Outer-tag Priority
- Inner-tag-based Priority
- Outer-tag-based Priority
- DSCP-based Priority

These priority assignments will pass through the whole system priority selection table to decide the packets internal priority. Afterwards the internal priority will point to the adaptive output queue ID table.

Priority Selection Tables

A received packet may be assigned up to five different priorities. These priorities are coordinated into a final priority according to the priority selection table Figure 16. Each priority assignment has a control register. The corresponding bit set to 1, sets the priority from high bit to low bit.

Inner-tag-based priority, Outer-tag-based priority, and DSCP-based priority may be NULL.

The priority arbiter should check whether the item is NULL or not. The NULL item priority corresponds to the lowest priority arbitration value; the bigger the corresponding priority arbitration value, the higher the priority assignment.

We can take an example to describe the priority order. The order is Inner-tag-based priority assignment > DSCP-based priority assignment > Outer-tag based priority assignment > Port-based Inner-tag Priority assignment = Port-based Outer-tag Priority assignment.

Priority weight	
Port-based Inner-tag Priority Assignment	1
Port-based Inner-tag Priority Assignment	1
DSCP-based Priority Assignment	6
Inner-tag-based Priority Assignment	7
Outer-tag-based Priority Assignment	5

Figure 16. Priority Selection Table Weight Rules Example

Internal Priority to Queue ID Table

The RTL8380M-VB/RTL8382M-VB can transfer its internal priority setting (see Figure 17) to the output queue ID. The RTL8380M-VB/RTL8382M-VB can configure each port's output queue level (including the CPU port). Each port has eight output queues.

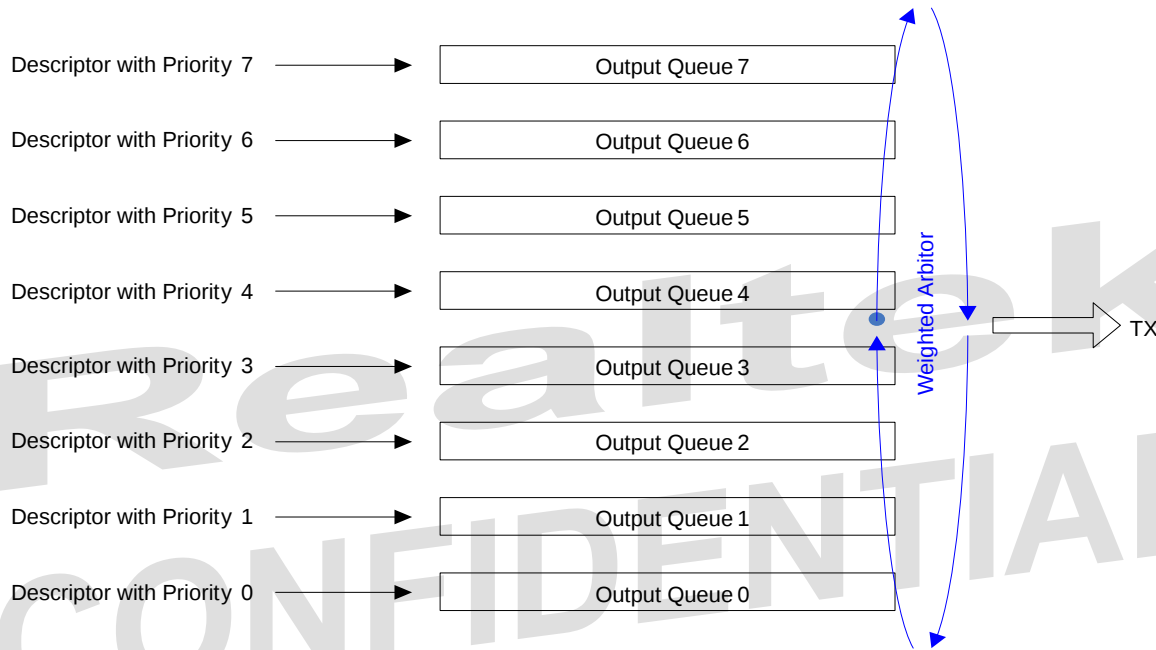


Figure 17. Per-Port Queue Management

7.19. Packet Scheduling (WRR and WFQ)

The Packet Scheduler controls the various traffic classes (i.e., controls the packet sending sequence of the priority queue). The RTL8380M-VB/RTL8382M-VB scheduling algorithm is divided into Weighted Fair-Queuing (WFQ) and Weighted Round-Robin (WRR). Note that the Strict Priority queue is the highest priority of all queues, and overrides WFQ & WRR. A larger strict priority queue ID indicates the priority is higher.

The Scheduler operates as follows:

- Weighted Fair-Queuing (WFQ): Byte-count
- Weighted Round-Robin (WRR): Packet-count

WFQ and WRR cannot exist at the same time. WFQ or WRR can co-exist with Strict Priority Schedule. Both WFQ and WRR are round robin, from large queue ID to small.

7.20. Packet Drop Algorithm (TD)

The RTL8380M-VB/RTL8382M-VB supports Tail Drop (TD).

- Tail Drop (TD): For a drop threshold value, if a packet meets queue overflow conditions before entering the output queue, the switch will drop this packet

7.21. Egress Packet Remarking

The RTL8380M-VB/RTL8382M-VB Remarking can be divided into Inner-tag remarking, Outer-tag remarking, and DSCP remarking.

- For Inner-tag remarking, there is an internal priority to inner-tag priority remarking table that is used to configure the final user inner-tag priority value for per-port egress of a packet
- For Outer-tag remarking, there is an internal priority to outer-tag priority remarking table that is used to configure the final Outer-tag priority value for per-port egress of a packet
- DSCP remarking also has an internal priority to DSCP priority table for per-port egress of a packet

7.22. Ingress and Egress Port Mirror

The RTL8380M-VB/RTL8382M-VB has four mirror sets (set0~3), and the Mirroring port can monitor several mirrored ports simultaneously. RX mirror and TX mirror function is supported by setting a source port mask, destination port mask. The mirror function can be configured across VLANs. The RTL8380M-VB/RTL8382M-VB supports a mirror filtering function to filter forwarded traffic. Only mirrored traffic can egress through a mirroring port.

The RTL8380M-VB/RTL8382M-VB provide a flexible flow-based mirror function. In a flow-based mirror, only specified packets will be mirrored through a configured ACL action and fill a corresponding traffic mirror table entry.

For flow control, the mirroring port will drop the mirrored packets and send PAUSE frames or backpressure signals to the mirrored port for normal packets. It will resume mirror function when flow control is back to normal status. The design limitations for mirroring settings are as below.

- Each mirror entry can only set one mirroring port
- A mirroring port cannot be a member of a trunk group
- The mirroring port is not limited by port isolation for mirrored packets

7.22.1. Remote Mirror (RSPAN)

The RTL8380M-VB/RTL8382M-VB support Remote Switched Port Analyzer (RSPAN) to analyze a remote device's traffic flow. The RTL8380M-VB/RTL8382M-VB defined RSPAN VLAN tag is illustrated in Figure 18. Users can configure the RSPAN tag's TPID/VID/Priority/CFI at each port. The RTL8380M-VB/RTL8382M-VB can parse for the RSPAN tag in RX and add or remove RSPAN tags in TX.

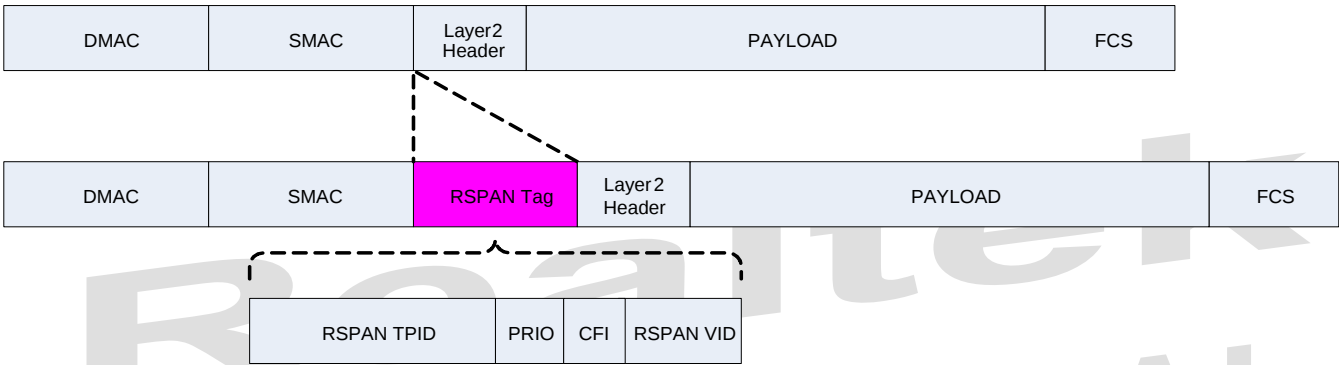


Figure 18. RSPAN Encapsulation

Figure 19 shows an example of an RSPAN application. In Source Switch A, Port0 is configured as a mirrored port, and Port2 as a mirroring port with setting 'TX added RSPAN tag'.

In Intermediate Switch B, Port3 and Port5 are added as RSPAN VLAN members. RSPAN mirrored packets will be forwarded without any modification.

In Destination Switch C, Port7 and Port9 join as RSPAN VLAN members, with Port9 configured to 'Remove RSPAN tag in TX'. This means packets are mirrored from Source Switch A Port0 to Destination Switch C Port9 without modification.

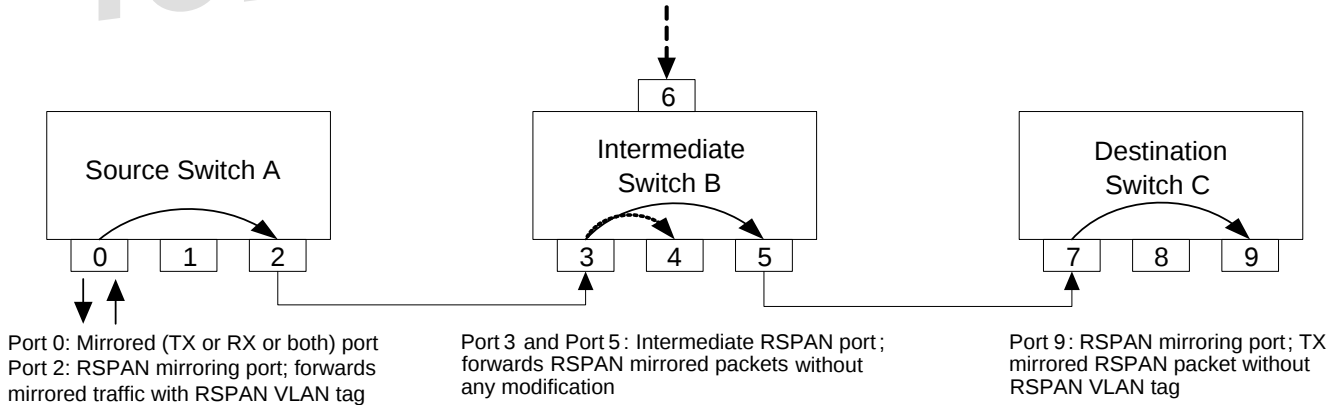


Figure 19. RSPAN Illustration

7.23. Management Information Base (MIB)

The RTL8380M-VB/RTL8382M-VB MIB (Management Information Base) counters include:

- Ethernet-like MIB (RFC 3635)
- Interface Group MIB (RFC 2863)
- RMON (Remote Network Monitoring) MIB (RFC 2819)
- Bridge MIB (RFC 1493)
- Bridge MIB Extension (RFC 2674)

7.24. NIC and CPU Tag Forwarding

NIC interface: This is used for receiving packets from the CPU, or transmitting packets to the CPU. The architecture is shown in Figure 20.

When a packet is sent from the switch core to the CPU port, the CPU tag can carry status information. The CPU tag can be divided into a transmit CPU tag, and a receive CPU tag.

- Transmit CPU Tag: Forces TX port mask. Indicates which ports the packet will NOT be sent to. For example, if we set port1, port2, and port5 mask bits, then the packet will not be sent to these ports
- Receive CPU Tag: Indicates which RX port the packet came from

If no CPU tag is attached, the normal process will be followed to perform a look-up in the L2 table.

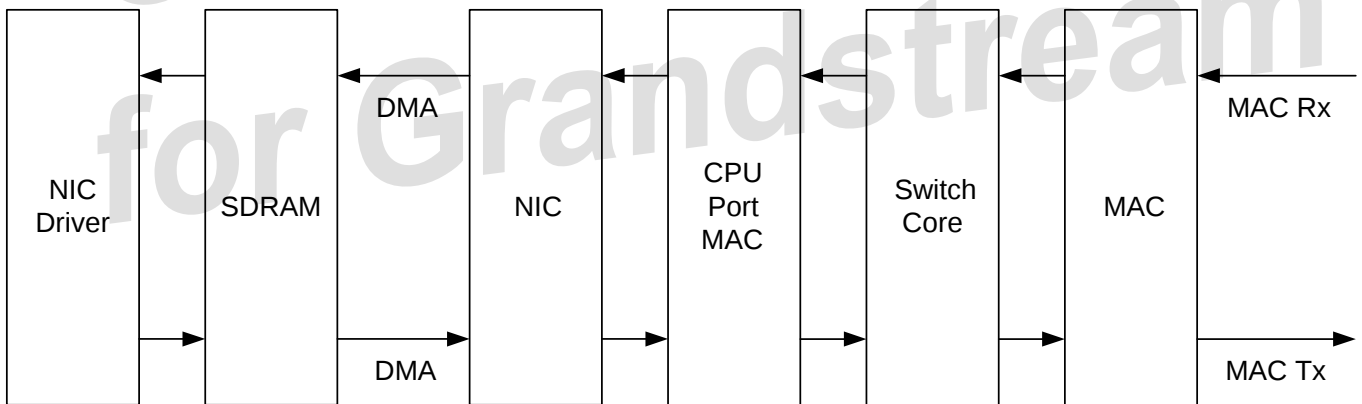


Figure 20. NIC Architecture

7.25. Indirect Table Access

The RTL8380M-VB/RTL8382M-VB employs an indirect method to set the control register and the data register to complete a VLAN/L2 Lookup/ Forwarding/SPT/ACL Table Access:

1. Sets the register to determine which table and which entry is to be accessed
2. Determines the read or write action
3. Hardware executes table access

Read: After the control register setup has been completed by software, hardware access then puts this data into the data register. Software then reads this data from the data register.

Write: The data is placed in the data register by software and the control register is set. Hardware writes this data to the table.

7.26. External PHY Register Access

After the RTL8380M-VB/RTL8382M-VB powers on and initializes, it will set the PHY MII register via MDC/MDIO. The RTL8380M-VB/RTL8382M-VB supports three access control registers to indirectly access an external PHY via the MDC/MDIO interface.

7.27. Switch Interrupt Indication

The RTL8380M-VB/RTL8382M-VB provides one global interrupt function: switch interrupt. Interrupt sources are listed below:

- Port Link Change interrupt
- Port SA learning constraint interrupt
- SerDes interrupt

8. CPU Function Description

8.1. *MIPS-4KEc*

- MIPS 4KEc CPU Core (Targeted at 500MHz): 5-stage pipeline, MIPS32 instruction set, additional MIPS16e instruction set support, 2 GPR sets (one shadow set), and vectored/Non-Maskable Interrupts (NMI) support
- Cache Configuration: I-Cache is 16KB, 4-way set associative, and 16-byte line size. D-Cache is 16KB, 4-way set associative, 16-byte line size, and write-back policy. It also has virtually indexed, physically tagged, and Prefetch instructions
- MMU Configuration: 4-entry ITLB, 4-entry DTLB, and 32-entry JTLB
- Misc.: Power-down mode, EJTAG support, internal BIST, internal real-time timer interrupts (Count/Compare registers), and CPU breakpoints

8.2. *SPI Flash*

The RTL8380M-VB/RTL8382M-VB support 32M-Byte (max) serial I/O, dual I/O SPI Flash.

8.3. *SDRAM Interface Configuration*

The RTL8380M-VB/RTL8382M-VB support 8-bit data bus DDR1/DDR2/DDR3 SDRAM.

9. Interface Descriptions

9.1. QSGMII

QSGMII-plus (Quad Serial Gigabit Media Independent Interface) reduces PCB complexity and IC pin count. This innovative 5Gbps serial interface provides an up to 10 inch MAC to PHY communication path. QSGMII can carry the full duplex gigabit Ethernet data streams of four ports simultaneously, using only 4 pins.

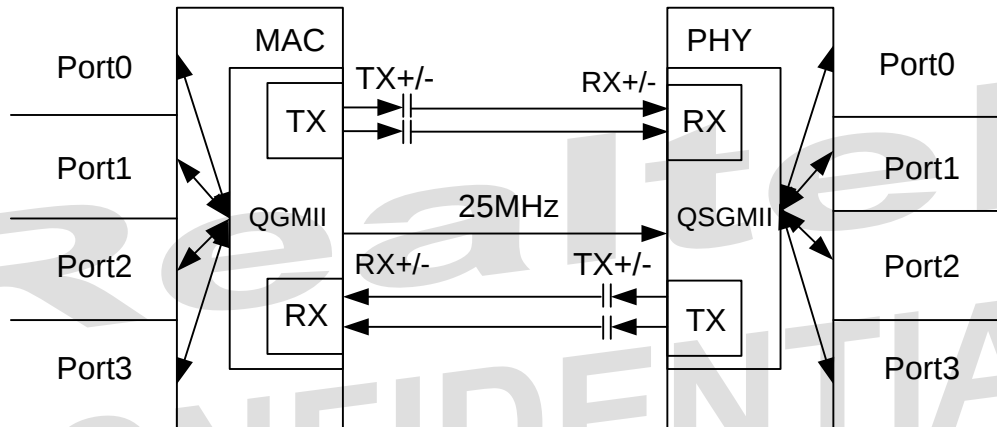


Figure 21. QSGMII Interconnection

9.2. SGMII

SGMII (Serial Gigabit Media Independent Interface) conveys PHY and MAC data with significantly less pins than required for GMII. It operates in both half and full duplex, and at all port speeds. It includes 4 data signals and 2 CLK signals to convey frame data and link rate information between the PHY and MAC. The data signals operate at 1.25Gbaud, and the CLK operates at 625MHz. Each of these signals is carried as a differential pair, thus providing signal integrity while minimizing system noise.

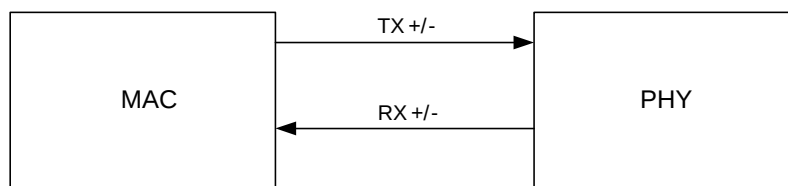


Figure 22. SGMII Signal

9.3. *DDR1 SDRAM*

The RTL8380M-VB/RTL8382M-VB support DDR1 SDRAM with the following features:

- Bus width is 8 bits
- One chip selection
- Supports 4 banks
- Row count range is 4~16K, and column count range is 512~4K
- Supports maximum 128M Bytes DDR1 SDRAM

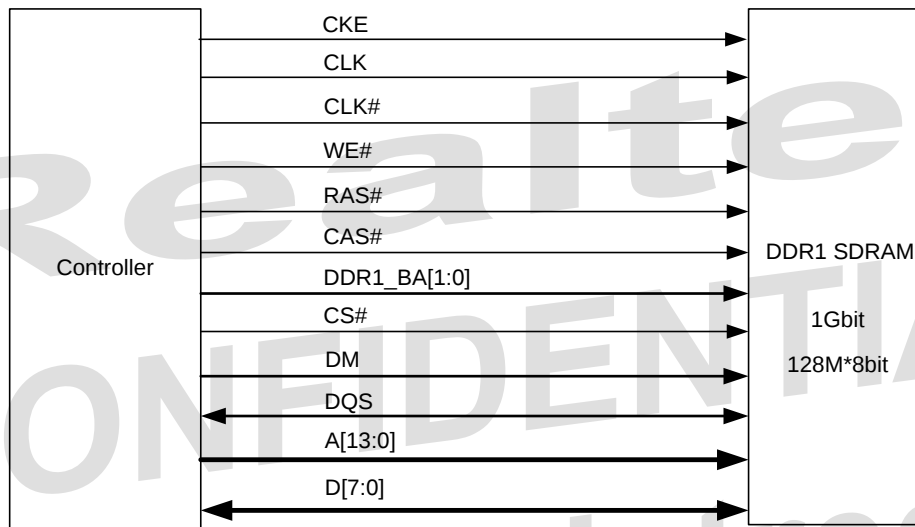


Figure 23. DDR1 SDRAM Configuration

9.4. DDR2 SDRAM

The RTL8380M-VB/RTL8382M-VB support DDR2 SDRAM with the following features:

- Bus width is 8 bits
- One chip selection
- Supports 4 banks or 8 banks
- Row count range is 4~16K, and column count range is 512~4K
- Supports maximum 128M Bytes DDR2 SDRAM

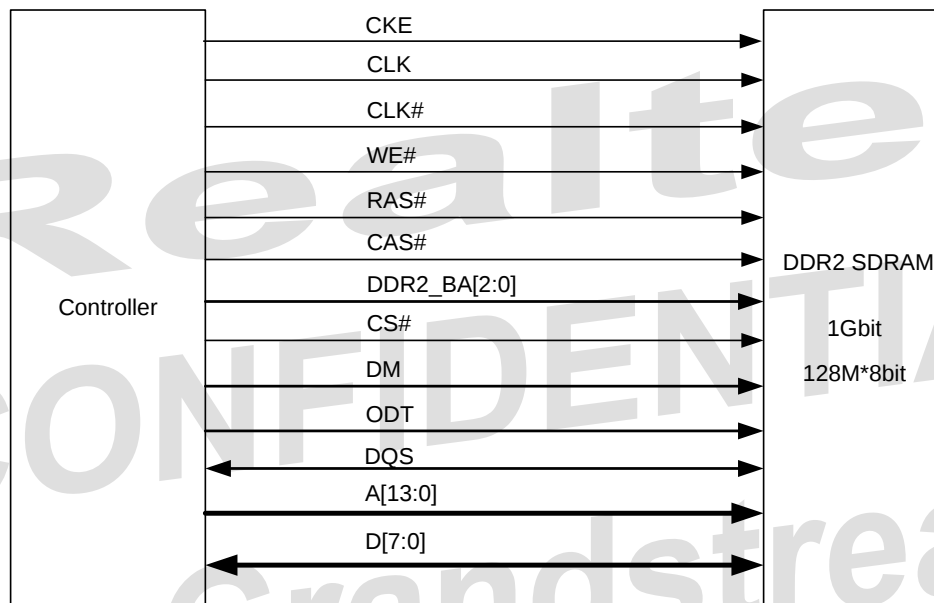


Figure 24. DDR2 SDRAM Configuration

9.5. DDR3 SDRAM

The RTL8380M-VB/RTL8382M-VB support DDR3 SDRAM with the following features:

- Bus width is 8 bits
- One chip selection
- Supports 8 banks
- Supports maximum 256M Bytes DDR3 SDRAM

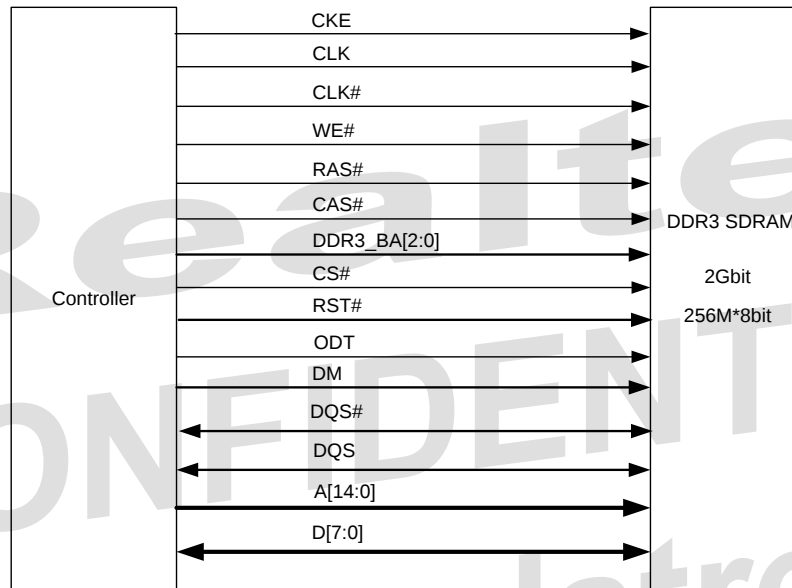


Figure 25. DDR3 SDRAM Configuration

9.6. SPI Flash Interface

The RTL8380M-VB/RTL8382M-VB support SPI Flash with the following features:

- Supports serial I/O, dual I/O SPI Flash (max)
- Supports both MMIO (Memory Mapped I/O) and PIO (Programmed I/O) mode
- One chip selection
- Supports maximum 32M Bytes SPI Flash in PIO mode and 16M Bytes in MMIO mode

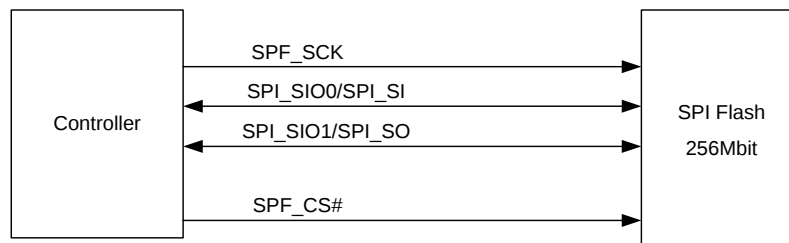


Figure 26. SPI Flash Configuration

9.7. UART

The RTL8380M-VB/RTL8382M-VB provides two UARTs, and each contains a 16-byte FIFO buffer. The baud rate can be up to 1Mbps and a programmable baud rate generator allows division of any input reference clock by 1 to 65535, and generates an internal 16x clock. The RTL8380M-VB/RTL8382M-VB provides a fully programmable serial interface.

In addition to the above functions, the RTL8380M-VB/RTL8382M-VB provides fully prioritized interrupt control and loopback functionality for diagnostic capabilities.

The UART interface pins are shown in the following table.

Table 33. UART Control Interface Pins

Signal Name	Type	Description
TXD#	Output	Transmit Data.
RXD#	Input	Receive Data.

9.8. EJTAG

EJTAG is inexpensive, and easy to implement. EJTAG utilizes the 5-pin IEEE 1149.1 JTAG (Joint Test Action Group) specification for off-chip communication. The interface pins are shown in Table 34.

Table 34. EJTAG Interface Pins

Signal Name	Type	Description
TDI	Input	Test Data In.
TDO	Output	Test Data Out.
TCK	Output	Test Clock.
TMS	Output	Test Mode Select.
TRST	Output (Optional)	Test Reset.

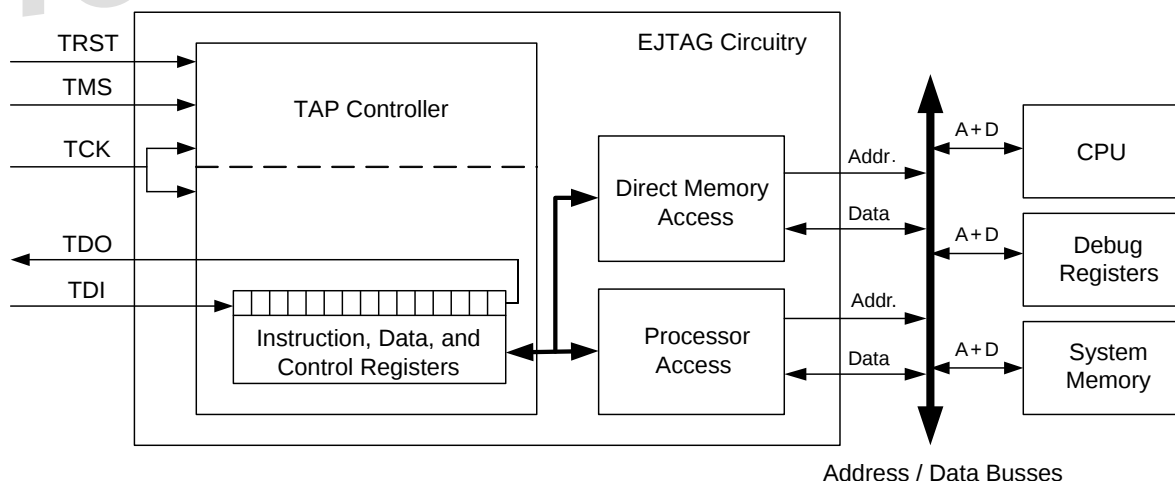


Figure 27. EJTAG Using a 5-Pin JTAG Interface to Access Data Block

EJTAG provides a path to access internal debug registers and circuitry that monitor and control the address and data busses of the processor. The DMA and Processor circuit blocks are used to setup and monitor the processor's internal busses and to execute the code from the EJTAG interface.

When an access is detected, the EJTAG circuitry makes the transaction address available in the EJTAG Address Register, and the appropriate data available in the EJTAG Data Register. It takes about 200 TCK periods to access 32-bit address and data registers in this fashion, so with a 40MHz TCK frequency, the access time is in the range of 5 μ s.

9.9. I2C Slave Interface

The RTL8380M-VB/RTL8382M-VB supports an I2C slave interface (Slave mode) for an external CPU to access the internal register.

The interface has two I/O pins (i.e., SDA and SCL). SDA is the access data signal, and SCL is the clock signal (typical clock is 1~2MHz). The read/write data sequence is shown below.

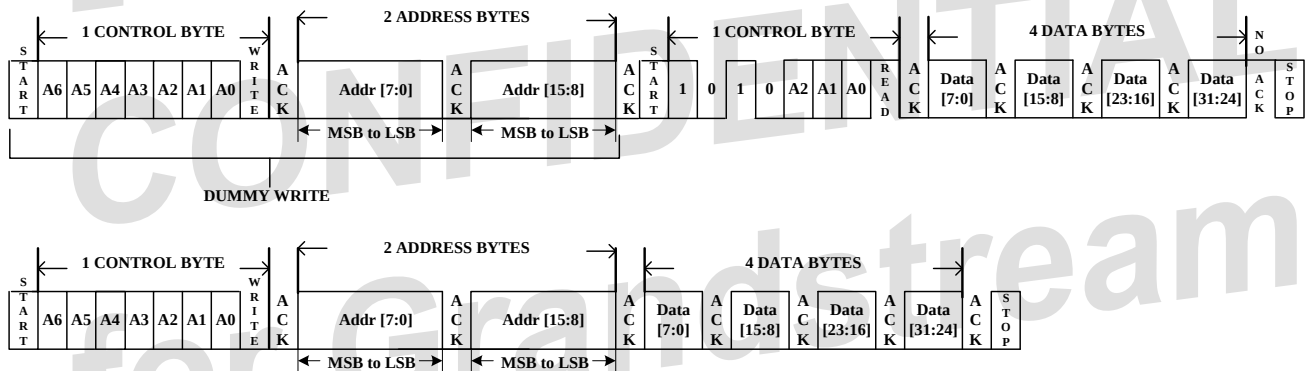


Figure 28. I2C Slave Interface Access Data Sequence

9.10. SPI Slave Interface

The RTL8380M-VB/RTL8382M-VB supports SPI slave interface (Slave mode) for an external CPU to access the internal register. The interface has four I/O pins (SI, SO, SCK, and CS#). The instruction sets are as shown in the following table.

Table 35. SPI Slave Interface

Instruction Name	Byte 1 (Code)	Byte 2	Byte 3	Byte 4	Byte 5	Byte 6	Byte 7	Byte 8
Write Data	02h	A23~A16	A15~A8	A7~A0	D31~D24	D23~D16	D15~D8	D7~D0
Read Data	03h	A23~A16	A15~A8	A7~A0	D31~D24	D23~D16	D15~D8	D7~D0

Note:

A23~A8: Maps to the switch's 16-bits register address.

A7~A0 in Write Data Instruction: Dummy byte for switch and conforms to standard SPI 24-bits address format.

A7~A0 in Read Data Instruction: Dummy byte waits for the switch to prepare the register data and conforms to standard SPI 24-bits address format.

D31~D0: 32-bits Register Data.

9.11. Serial LED

The RTL8380M-VB/RTL8382M-VB supports a serial LED interface to display the link status. The serial LED interface, LED_CLK and LED_DA provide clock and data to enable/disable the external shift registers. A 74HC164 8-Bit Serial-In, Parallel-Out Shift Register captures the per-port link status and diagnostic information. In serial shift LED mode, the RTL8380M-VB/RTL8382M-VB supports per-port one/two/three single-color LED to show the speed, link status, and other information.

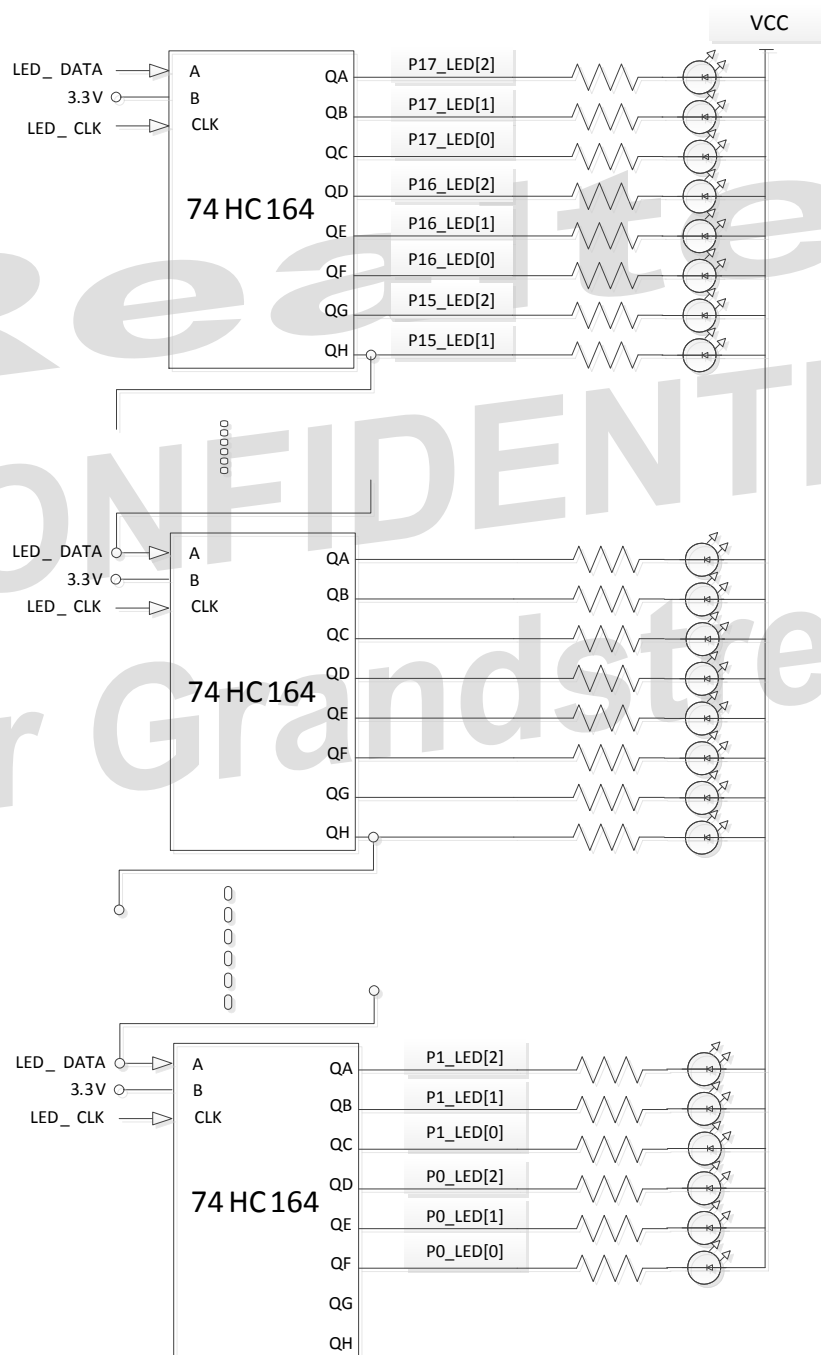


Figure 29. Serial LED Connection

The default LED status for the RTL8380M-VB/RTL8382M-VB is as follows:

LED Number	3-LEDs
LED0 Definition	1000M Link
LED1 Definition	100M Link
LED2 Definition	Link/Act

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10. Electrical AC/DC Characteristics

10.1. Absolute Maximum Ratings

WARNING: Absolute maximum ratings are limits beyond which permanent damage may be caused to the device, or device reliability will be affected. All voltages are specified referenced to GND unless otherwise specified.

Table 36. Absolute Maximum Ratings

Parameter	Min	Max	Units
Junction Temperature (Tj)	-	+125	°C
Storage Temperature	-45	+125	°C
DVDDH, AVDDH, SVDDH, AVDDH_PLL Supply Referenced to DGND and AGND	2.97	3.63	V
DVDDL, AVDDL, SVDDL, AVDDL_PLL, PLLVDDL Supply Referenced to DGND and AGND	0.90	1.18	V
MVDDH Supply Referenced to DGND (for DDR1)	2.375	2.625	V
MVDDH Supply Referenced to DGND (for DDR2)	1.71	1.89	V
MVDDH Supply Referenced to DGND (for DDR3)	1.425	1.575	V

10.2. Operating Range

Table 37. Recommended Operating Range

Parameter	Min	Typical	Max	Units
Ambient Operating Temperature (Ta)	0	-	55	°C
DVDDH, AVDDH, SVDDH, AVDDH_PLL Supply Voltage Range	3.135	3.3	3.465	V
DVDDL, AVDDL, AVDDL_PLL, PLLVDDL Supply Voltage Range	0.95	1.1	1.15	V
SVDDL Supply Voltage Range	1.05	1.1	1.15	V
MVDDH Supply Voltage Range(for DDR1)	2.375	2.5	2.625	V
MVDDH Supply Voltage Range(for DDR2)	1.71	1.8	1.89	V
MVDDH Supply Voltage Range(for DDR3)	1.425	1.5	1.575	V

10.3. DC Characteristics

Table 38. DC Characteristics (IO Power =3.3V)

Symbol	Parameter	Min	Typical	Max	Units
V _{IH}	TTL Input High Voltage	2.0	-	-	V
V _{IL}	TTL Input Low Voltage	-	-	0.8	V
V _{OH}	Output High Voltage	2.4	-	-	V
V _{OL}	Output Low Voltage	-	-	0.4	V

10.4. AC Characteristics

10.4.1. QSGMII Differential Transmitter Characteristics

Table 39. QSGMII Differential Transmitter Characteristics

Symbol	Parameter	Min	Typical	Max	Units	Notes
UI	Unit Interval	199.94	200	200.06	ps	200ps±300ppm
T_X1	Eye Mask	-	-	0.2	UI	-
T_X2	Eye Mask	-	-	0.4	UI	-
T_Y1	Eye Mask	150	-	-	mV	-
T_Y2	Eye Mask	-	-	650	mV	-
V _{TX-DIFFp-p}	Output Differential Voltage	600	900	1300	mV	-
T _{TX-EYE}	Minimum TX Eye Width	0.6	-	-	UI	-
T _{TX-JITTER}	Output Jitter	-	-	0.4	UI	-
T _{TX-RISE}	Output Rise Time	0.15	-	-	UI	-
T _{TX-FALL}	Output Fall Time	0.15	-	-	UI	-
R _{TX}	Differential Resistance	80	100	120	ohm	-
C _{TX}	AC Coupling capacitor	75	100	200	nF	-
L _{TX}	Transmit Length in PCB	-	-	10	inch	-

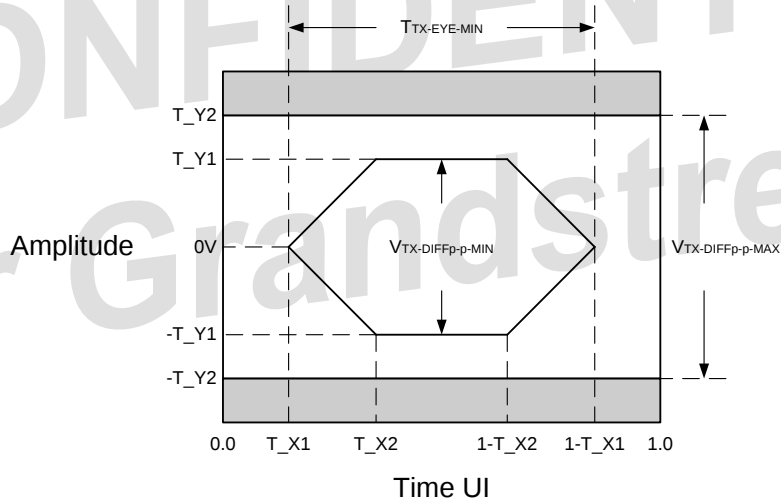


Figure 30. QSGMII Differential Transmitter Eye Diagram

10.4.2. QSGMII Differential Receiver Characteristics

Table 40. QSGMII Differential Receiver Characteristics

Symbol	Parameter	Min	Typical	Max	Units	Notes
UI	Unit Interval	199.94	200	200.06	ps	200ps±300ppm
R_X1	Eye Mask	-	-	0.3	UI	-
R_Y1	Eye Mask	100	-	-	mV	-
R_Y2	Eye Mask	-	-	650	mV	-
V _{RX-DIFFp-p}	Input Differential Voltage	200	-	1300	mV	-
T _{RX-EYE}	Minimum RX Eye Width	0.4	-	-	UI	-

Symbol	Parameter	Min	Typical	Max	Units	Notes
$T_{RX-JITTER}$	Input Jitter Tolerance	-	-	0.6	UI	-
R_{RX}	Differential Resistance	80	100	120	ohm	-

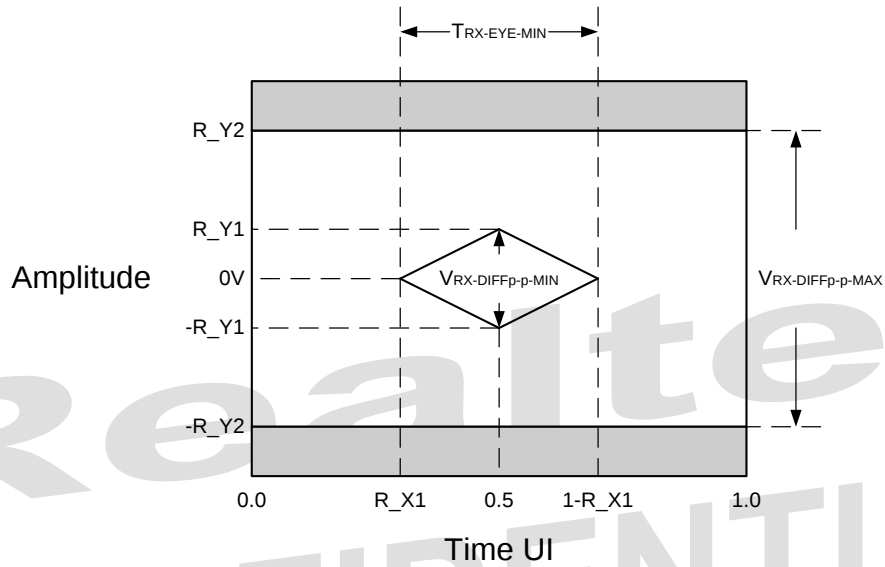


Figure 31. QSGMII Differential Receiver Eye Diagram

10.4.3. SGMII Differential Transmitter Characteristics

Table 41. SGMII Differential Transmitter Characteristics

Symbol	Parameter	Min	Typical	Max	Units	Notes
UI	Unit Interval	799.76	800	800.24	ps	800ps±300ppm
T_X1	Eye Mask	-	-	0.1875	UI	-
T_X2	Eye Mask	-	-	0.4	UI	-
T_Y1	Eye Mask	125	-	-	mV	-
T_Y2	Eye Mask	-	-	500	mV	-
V _{TX-DIFFp-p}	Output Differential Voltage	400	700	900	mV	
T _{TX-EYE}	Minimum TX Eye Width	0.625	-	-	UI	-
T _{TX-JITTER}	Output Jitter	-	-	0.375	UI	-
R _{TX}	Differential Resistance	80	100	120	ohm	-
C _{TX}	AC Coupling capacitor	75	100	200	nF	-
L _{TX}	Transmit Length in PCB	-	-	10	inch	-

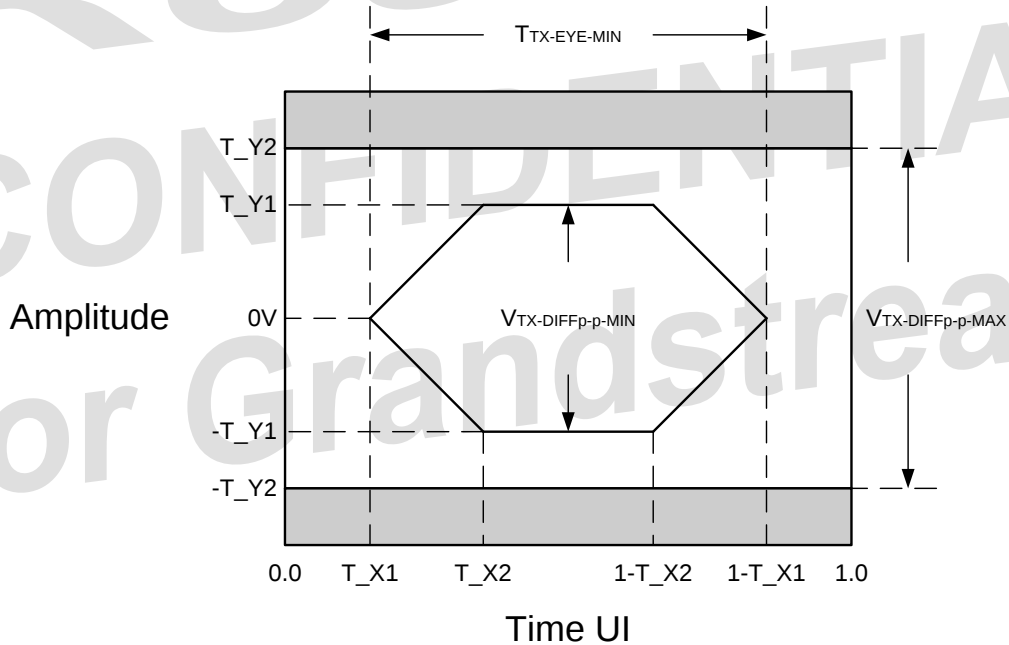


Figure 32. SGMII Differential Transmitter Eye Diagram

10.4.4. SGMII Differential Receiver Characteristics

Table 42. SGMII Differential Receiver Characteristics

Symbol	Parameter	Min	Typical	Max	Units	Notes
UI	Unit Interval	799.76	800	800.24	ps	800ps±300ppm
R_X1	Eye Mask	-	-	0.3125	UI	-
R_Y1	Eye Mask	50	-	-	mV	-
R_Y2	Eye Mask	-	-	600	mV	-
$V_{RX-DIFFp-p}$	Input Differential Voltage	100	-	1200	mV	-
T_{RX-EYE}	Minimum RX Eye Width	0.375	-	-	UI	-
$T_{RX-JITTER}$	Input Jitter Tolerance	-	-	0.625	UI	-
R_{RX}	Differential Resistance	80	100	120	ohm	-

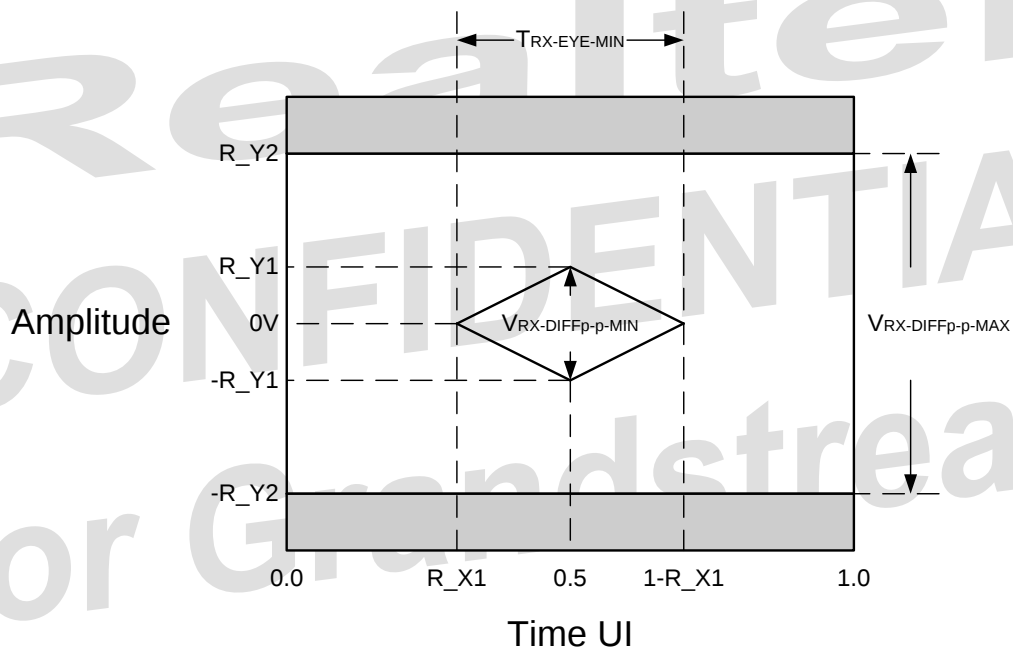


Figure 33. SGMII Differential Receiver Eye Diagram

10.4.5. 1000Base-X/100Base-FX Differential Transmitter Characteristics

Table 43. 1000Base-X/100Base-FX Differential Transmitter Characteristics

Symbol	Parameter	Min	Typical	Max	Units	Notes
UI	Unit Interval (1000Base-X)	799.76	800	800.24	ps	800ps $\pm$ 300ppm
	Unit Interval (100Base-FX)	7.9976	8.0	8.0024	ns	8ns $\pm$ 300ppm
T_X1	Eye Mask	-	-	0.1875	UI	-
T_X2	Eye Mask	-	-	0.4	UI	-
T_Y1	Eye Mask	125	-	-	mV	-
T_Y2	Eye Mask	-	-	650	mV	-
V _{TX-DIFFp-p}	Output Differential Voltage	400	800	1300	mV	-
T _{TX-EYE}	Minimum TX Eye Width	0.625	-	-	UI	-
T _{TX-JITTER}	Output Jitter	-	-	0.375	UI	-
R _{TX}	Differential Resistance	80	100	120	ohm	-
C _{TX}	AC Coupling capacitor	75	100	200	nF	-
L _{TX}	Transmit Length in PCB	-	-	10	inch	-

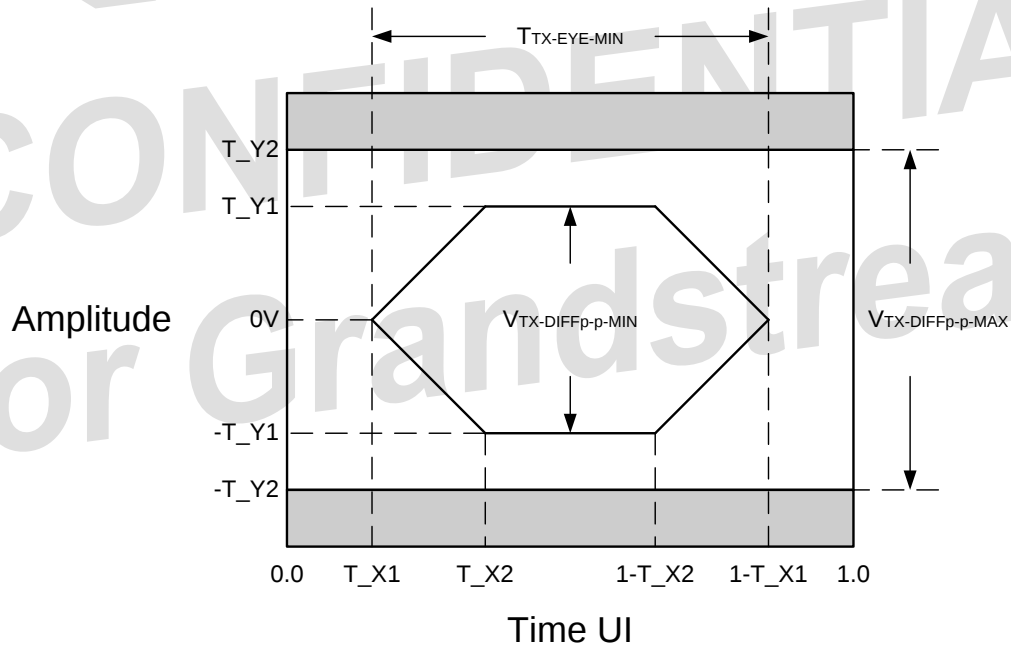


Figure 34. 1000Base-X/100Base-FX Differential Transmitter Eye Diagram

10.4.6. 1000Base-X/100Base-FX Differential Receiver Characteristics

Table 44. 1000Base-X/100Base-FX Differential Receiver Characteristics

Symbol	Parameter	Min	Typical	Max	Units	Notes
UI	Unit Interval (1000Base-X)	799.76	800	800.24	ps	800ps±300ppm
	Unit Interval (100Base-FX)	7.9976	8.0	8.0024	ns	8ns±300ppm
R_X1	Eye Mask	-	-	0.3125	UI	-
R_Y1	Eye Mask	100	-	-	mV	-
R_Y2	Eye Mask	-	-	1000	mV	-
V _{RX-DIFFp-p}	Input Differential Voltage	200	-	2000	mV	-
T _{RX-EYE}	Minimum RX Eye Width	0.375	-	-	UI	-
T _{RX-JITTER}	Input Jitter Tolerance	-	-	0.625	UI	-
R _{RX}	Differential Resistance	80	100	120	ohm	-

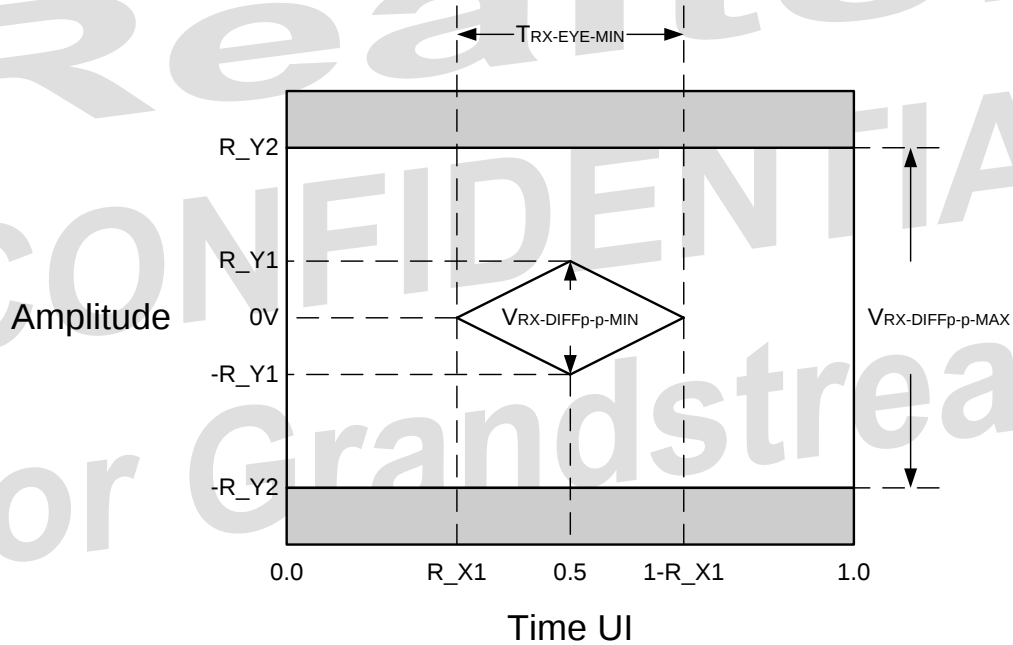


Figure 35. 1000Base-X/100Base-FX Differential Receiver Eye Diagram

10.4.7. DDR2 Characteristics

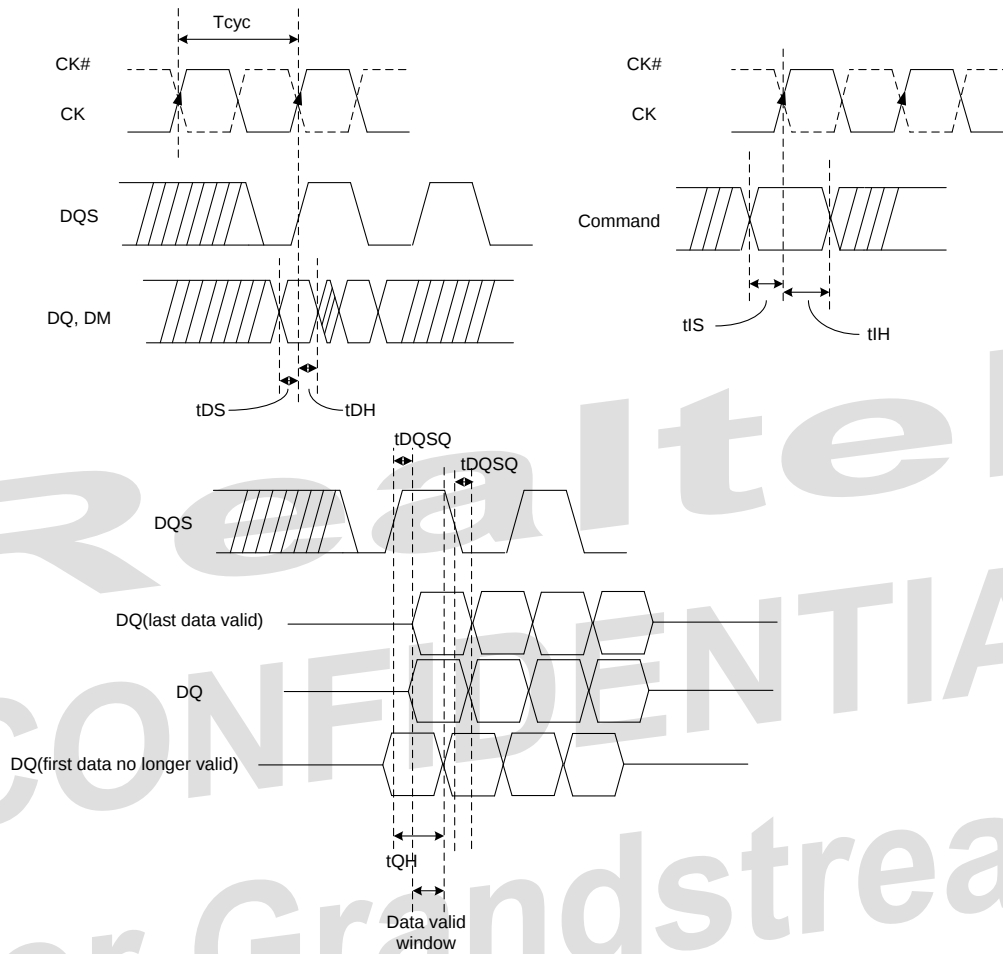


Figure 36. DDR2 Timing Characteristics

Table 45. DDR2 SDRAM Timing Characteristics

Symbol	Description	Min	Typical	Max	Units
$f_{CK}, f_{CK\#}$	Clock Frequency of the CK and CK#	-	300	-	MHz
Duty	Duty Cycle of the CK and CK#	48	50	52	%
t_{JITper}	Clock period jitter	-110	-	110	ps
t_{JITcc}	Cycle-to-cycle jitter	-220	-	220	ps
t_{DS}	DQ and DM Output Setup Time	450	-	-	ps
t_{DH}	DQ and DM Output Hold Time	450	-	-	ps
t_{IS}	Address and Control Output Setup Time	600	-	-	ps
t_{IH}	Address and Control Output Hold Time	600	-	-	ps
t_{DQSQ}	Input DQS–DQ Skew, DQS to Last DQ Valid	-	-	300	ps
t_{QH}	Input DQ–DQS Hold, DQS to First DQ to Go Non-Valid	0.3	-	-	CK

Note: Test Condition, $f_{DDR_CK}=300MHz$.

10.4.8. DDR3 Characteristics

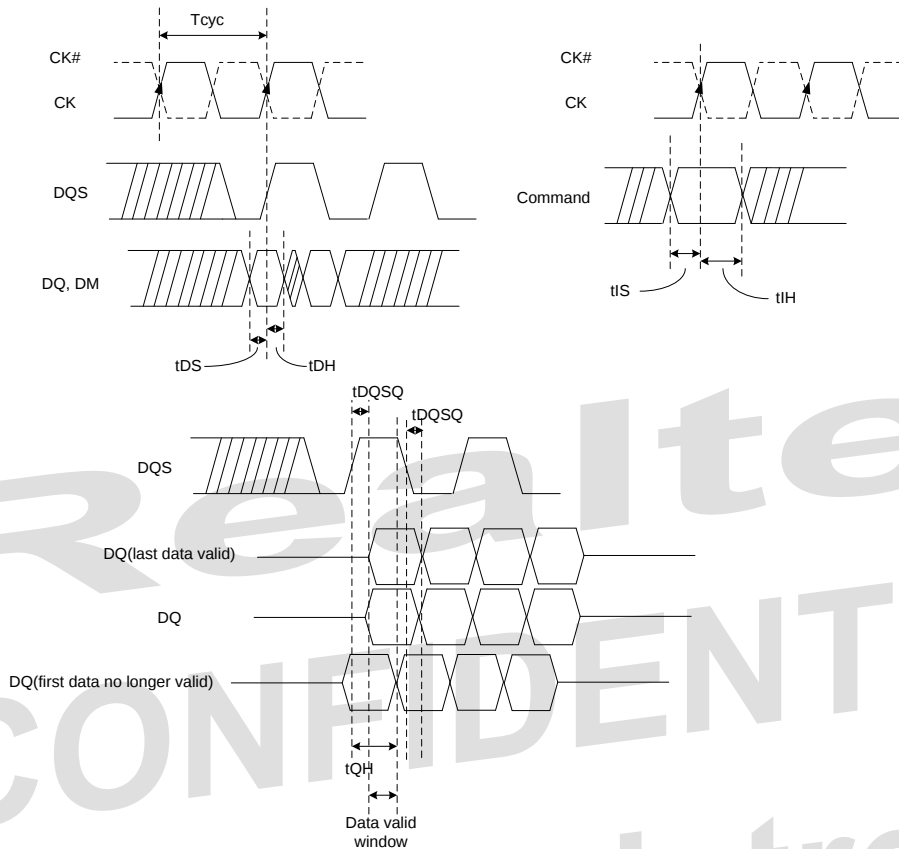


Figure 37. DDR3 Timing Characteristics

Table 46. DDR3 SDRAM Timing Characteristics

Symbol	Description	Min	Typical	Max	Units
$f_{CK}, f_{CK\#}$	Clock Frequency of the CK and CK#	-	300	-	MHz
Duty	Duty Cycle of the CK and CK#	47	50	53	%
t_{JITper}	Clock period jitter	-90	-	90	ps
t_{JITcc}	Cycle-to-cycle jitter	-165	-	165	ps
t_{DS}	DQ and DM Output Setup Time	450	-	-	ps
t_{DH}	DQ and DM Output Hold Time	400	-	-	ps
t_{IS}	Address and Control Output Setup Time	750	-	-	ps
t_{IH}	Address and Control Output Hold Time	550	-	-	ps
t_{DQSQ}	Input DQS-DQ Skew, DQS to Last DQ Valid	-	-	300	ps
t_{QH}	Input DQ-DQS Hold, DQS to First DQ to Go Non-Valid	0.3	-	-	CK

Note: Test Condition, $f_{DDR_CK}=300MHz$.

10.4.9. SPI Interface Characteristics

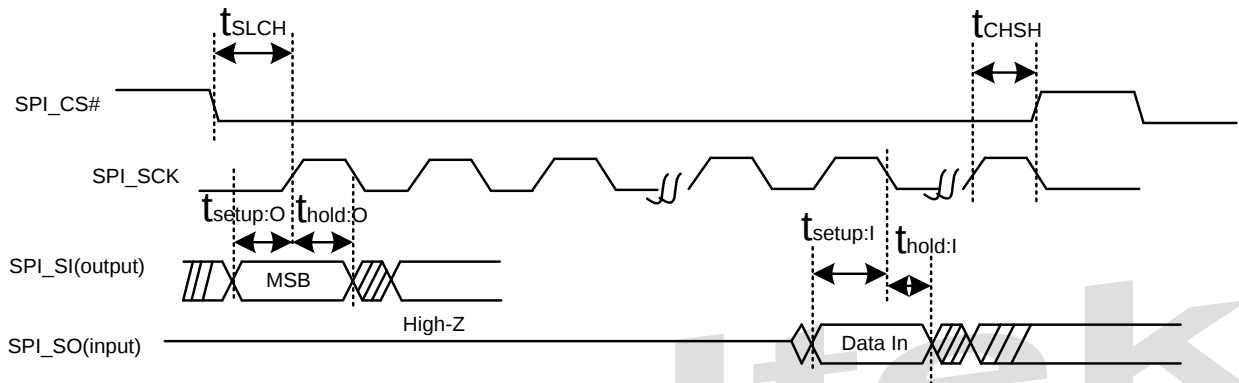


Figure 38. SPI Interface Timing

Table 47. SPI Interface Timing Characteristics

Symbol	Description	Min	Typical	Max	Units
f_{SPI_SCK}	Clock Frequency of the SPI_SCK	49.5	50	50.5	MHz
Duty	Duty Cycle of the SPI_SCK	45	50	55	%
t_{SLCH}	CS# Active Setup Time	7	8.1	-	ns
t_{CHSH}	CS# Active Hold Time	8	9.65	-	ns
$t_{setup:O}$	Data Output Setup Time	4	8.3	-	ns
$t_{hold:O}$	Data Output Hold Time	6	9.65	-	ns
$t_{setup:I}$	Data Input Setup Time	4	-	-	ns
$t_{hold:I}$	Data Input Hold Time	0	-	-	ns

Note: Test Condition, $f_{SPI_SCK}=50\text{MHz}$.

10.4.10. SMI (MDC/MDIO) Interface Characteristics

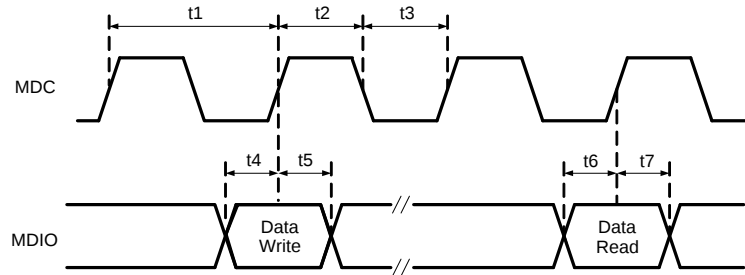


Figure 39. SMI (MDC/MDIO) Timing

Table 48. SMI (MDC/MDIO) Timing Characteristics

Symbol	Description	Min	Typ	Max	Units
t1	MDC Clock Period	380	-	-	ns
t2	MDC High Time	-	190	-	ns
t3	MDC Low Time	-	190	-	ns
t4	MDIO to MDC Rising Setup Time (Write Data)	-	190	-	ns
t5	MDIO to MDC Rising Hold Time (Write Data)	-	190	-	ns
t6	MDIO to MDC Rising Setup Time (Read Data)	40	-	-	ns
t7	MDIO to MDC rising hold time (Read Data)	2	-	-	ns

10.4.11. Serial Mode LED

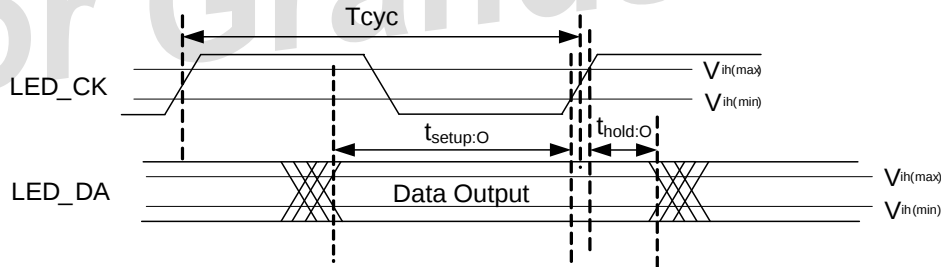


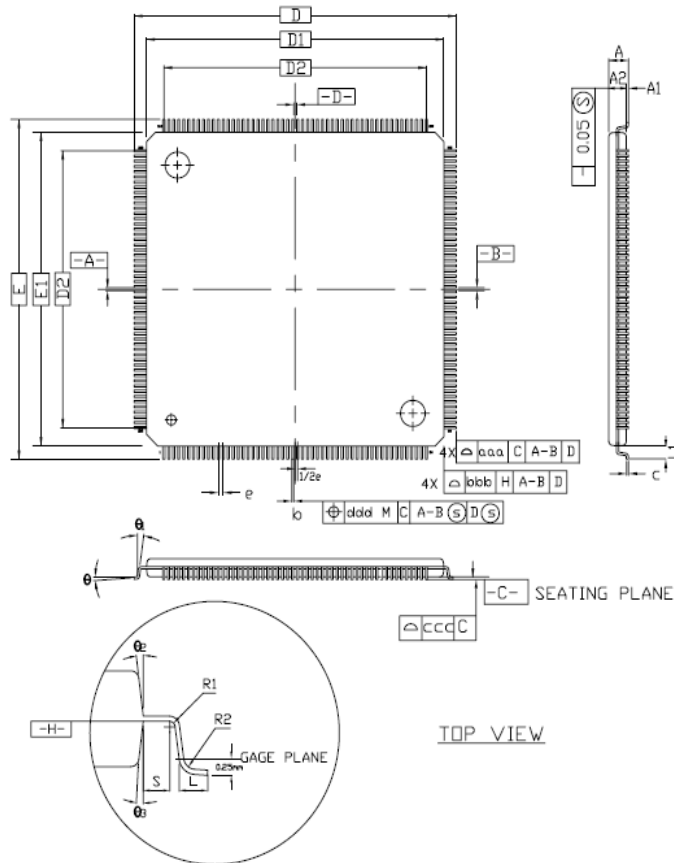
Figure 40. Serial Mode LED AC Timing Parameters

Table 49. Serial Mode LED AC Timing

Mode and Description		Symbol	Min	Typical	Max	Units
Serial LED	Input High Voltage	Vih	2.0	-	-	V
	Input Low Voltage	Vil	-	-	0.8	V
	LED_CK Clock Cycle	Tcyc	-	600	-	ns
	Duty Cycle of the LED_CK	Duty	45	50	55	%
	LED_DA to LED_CK Output Setup Time	t _{setup:O}	-	314	-	ns
	LED_DA to LED_CK Output Hold Time	t _{hold:O}	-	285	-	ns

11. Package Information

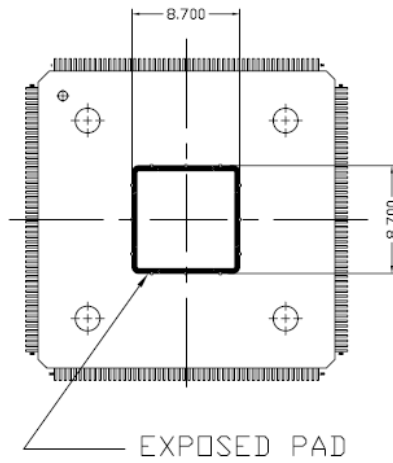
11.1. LQFP216-E-PAD (24*24mm)



CONTROL DIMENSIONS ARE IN MILLIMETERS.

SYMBOL	MILLIMETER			INCH		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	—	—	1.60	—	—	0.063
A1	0.05	—	0.15	0.002	—	0.006
A2	1.35	1.40	1.45	0.053	0.055	0.057
D	26.00 REF.			1.024 BSC.		
D1	24	REF.	—	0.945 BSC.		
E	26.00 REF.			1.024 BSC.		
E1	24	REF.	—	0.945 BSC.		
R2	0.08	—	0.20	0.003	—	0.008
R1	0.08	—	—	0.003	—	—
θ	0°	3.5°	7°	0°	3.5°	7°
θ1	0°	—	—	0°	—	—
θ2	11°	12°	13°	11°	12°	13°
θ3	11°	12°	13°	11°	12°	13°
C	0.09	—	0.20	0.004	—	0.008
L	0.45	0.60	0.75	0.018	0.024	0.030
L1	1.00 REF.			0.039 REF.		
S	0.20	—	—	0.008	—	—

ASE		SCALE		PROJ.	
TITLE		DWG. NO.		REV.	
PACKAGE OUTLINE		AAA09691		0	
216 L LQFP		SHEET		SIZE	
24 x 24 x 1.40 mm		1 OF 3		A4	
2.0 mm FOOTPRINT					
UNIT		TOLERANCE		REFERENCE DOCUMENT	
DIMENSION		ANGLE			
INCH / MM					



BOTTOM VIEW

NOTES :

1. DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION.
2. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED THE MAXIMUM b DIMENSION BY MORE THAN 0.08mm.
DAMBAR CAN NOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. THE MINIMUM SPACE BETWEEN PROTRUSION AND AN ADJACENT LEAD SHALL NOT BE LESS THAN 0.07mm.
3. THE TOP PACKAGE BODY SIZE MAY BE SMALLER THAN THE BOTTOM PACKAGE BODY SIZE.

SYMBOL	216L					
	MILLIMETER			INCH		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
b	0.13	0.16	0.23	0.005	0.006	0.009
e	0.40 BSC.			0.016 BSC.		
D2	21.20			0.835		
E2	21.20			0.835		
TOLERANCES OF FORM AND POSITION						
aaa	0.20			0.008		
bbb	0.20			0.008		
ccc	0.08			0.003		
ddd	0.07			0.003		

ASE		SCALE	PROJ.	REV.
TITLE		DWG. NO.		0
216 L LQFP		AAA09691		
24 x 24 x 1.40 mm		SHEET		SIZE
2.0 mm FOOTPRINT		2 OF 3		A4
UNIT		TOLERANCE		REFERENCE DOCUMENT
INCH / MM		DIMENSION		ANGLE

12. Ordering Information

Table 50. Ordering Information

Part Number	Package	Status
RTL8380M-VB-CG	LQFP 216-Pin E-PAD (24*24mm) 'Green' Package (Managed)	MP
RTL8382M-VB-CG	LQFP 216-Pin E-PAD (24*24mm) 'Green' Package (Managed)	MP

Note: See page 10 (RTL8380M-VB), page 25 (RTL8382M-VB) for package identification.

Realtek
CONFIDENTIAL
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Realtek Semiconductor Corp.

Headquarters

No. 2, Innovation Road II, Hsinchu Science Park,
Hsinchu 300, Taiwan, R.O.C.
Tel: 886-3-5780211 Fax: 886-3-5776047
www.realtek.com